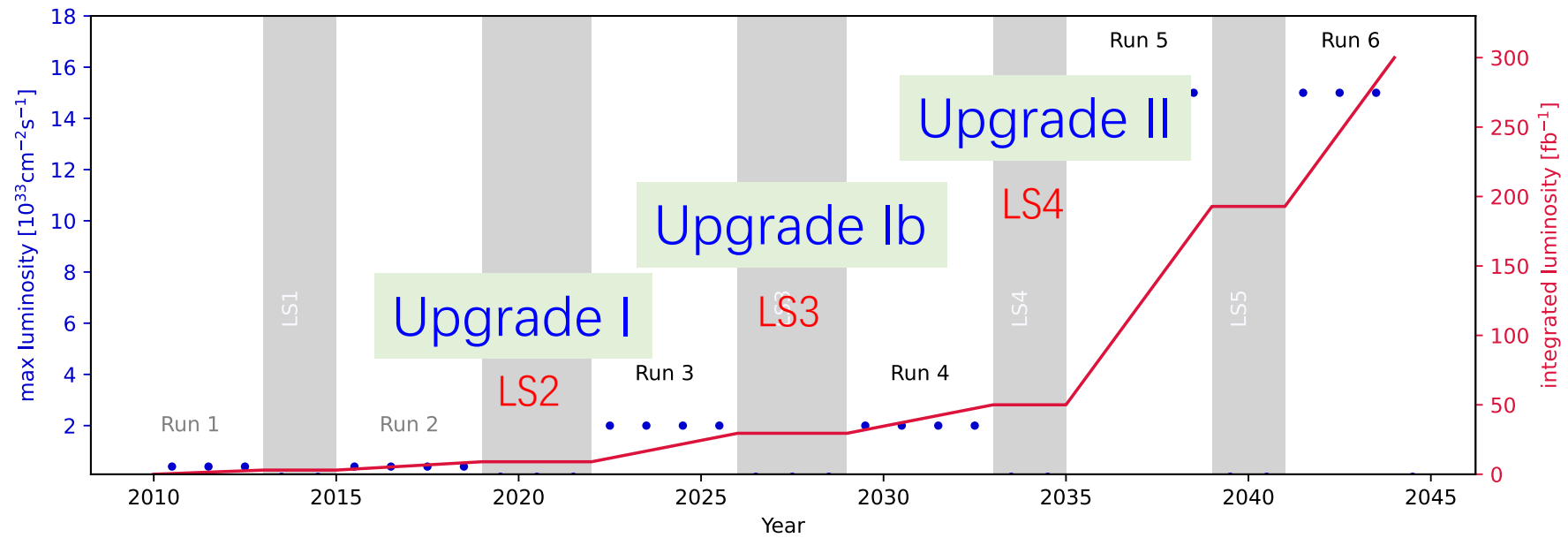


LHCb Upgrades



Zhenwei Yang (杨振伟)

北京大学物理学院

2023.11.17

Contents

- Introduction: the past
 - LHCb in Run 1&2
- LHCb Upgrade I: the present
 - Run 3&4
- LHCb Upgrade II: the future
 - Run 5&6...
- Summary

The born of LHCb

LHC-B

CERN/LHCC 95-5
LHCC/ I 8
25 August 1995

Last update
28 March 1996

LETTER OF INTENT

A Dedicated LHC Collider Beauty Experiment
for Precision Measurements of CP-Violation

In colliding mode instead of fixed-target

Abstract

The LHC-B Collaboration proposes to build a forward collider detector dedicated to the study of CP violation and other rare phenomena in the decays of Beauty particles. The forward geometry results in an average 80 GeV momentum of reconstructed B-mesons and, with multiple, efficient and redundant triggers, yields large event samples. B-hadron decay products are efficiently identified by Ring-Imaging Cerenkov Counters, rendering a wide range of multi-particle final states accessible and providing precise measurements of all angles, α, β and γ of the unitarity triangle. The LHC-B microvertex detector capabilities facilitate multi-vertex event reconstruction and proper-time measurements with an expected few-percent uncertainty, permitting measurements of B_s -mixing well beyond the largest conceivable values of x_s . LHC-B would be fully operational at the startup of LHC and requires only a modest luminosity to reveal its full performance potential.

... dedicated to the study of CPV
and other rare phenomena in the
decays of Beauty particles.

... precise measurements of the
CKM angles...

Original members in LOI

IHPE, Beijing, P.R.C.

C. Jiang, S. Kang, X. Li, F. Sun, X. Xia

University of Science and Technology of China, Hefei, P.R.C.

X.-Q. Yu, G. Jin, X.-S. Lin, T.-K. Liu, X.-Y. Wu

Nanjing University, Nanjing, P.R.C.

T.-Y. Chen, D. Gao, Z.-X. Sha, D. Xi, Z.-W. Zhang

Members of the LHC-B Collaboration

University of Aarhus - Institute for Synchrotron Radiation, Aarhus, Denmark
K. Kirsebom, S.P. Møller, E. Uggerhøj

Collège de France, Paris, France
J. Seguinot, T. Ypsilantis

DAPNIA, CE-Saclay, Gif-sur-Yvette, France
J. Zsembery

Humboldt University, Berlin, Germany
T. Lohse, R. Mankel

University of Freiburg, Freiburg, Germany
H. Fischer, J. Franz, K. Königsmann, H. Schmitt

Physikalisches Institut, University of Heidelberg, Heidelberg, Germany
P. Bock, F. Eisele, M. Feuerstack, A. Hölscher, P. Igo-Kemenes, J. von Krogh, P. Schleper, U. Straumann

Max-Planck-Institut für Kernphysik, Heidelberg, Germany
K.-T. Knöpfle, M. Schmelling, W. Hofmann

University of Bologna and INFN, Bologna, Italy
A. Bertin, M. Bruschi, M. Capponi, I. D'Antone, S. De Castro, A. Ferretti, D. Galii, B. Giacobbe, U. Marconi, I. Massa, M. Piccinini, M. Poli, N. Semprini-Cesari, R. Spighi, S. Vecchi, A. Vezzani, F. Vigotti, M. Villa, A. Vitale, A. Zoccoli

University of Rome - "La Sapienza" and INFN, Rome, Italy
A. Frenkel, G. Martellotti, G. Penso

University of Rome - "Tor Vergata" and INFN, Rome, Italy
G. Carboni

NIKHEF, Amsterdam, The Netherlands
¹University of Amsterdam, ²University of Utrecht, ³Foundation for Fundamental Research of Matter in the Netherlands
G. v. Apeldoorn¹, Th.S. Bauer^{2,3}, A. Buijs², W. Hoogland³, B. Koene³, P.M. Kooijman¹, M. Merk³, W. Ruckstuhl³, J. Timmermans³, J. Visschers³, L. Wiggers³

University of Lodz, Poland
J. Kempa, J. Wdowczyk, T. Wibig, Inz.J. Zabierowski

IHPE, Beijing, P.R.C.
C. Jiang, S. Kang, X. Li, F. Sun, X. Xia

University of Science and Technology of China, Hefei, P.R.C.
X.-Q. Yu, G. Jin, X.-S. Lin, T.-K. Liu, X.-Y. Wu

Nanjing University, Nanjing, P.R.C.
T.-Y. Chen, D. Gao, Z.-X. Sha, D. Xi, Z.-W. Zhang

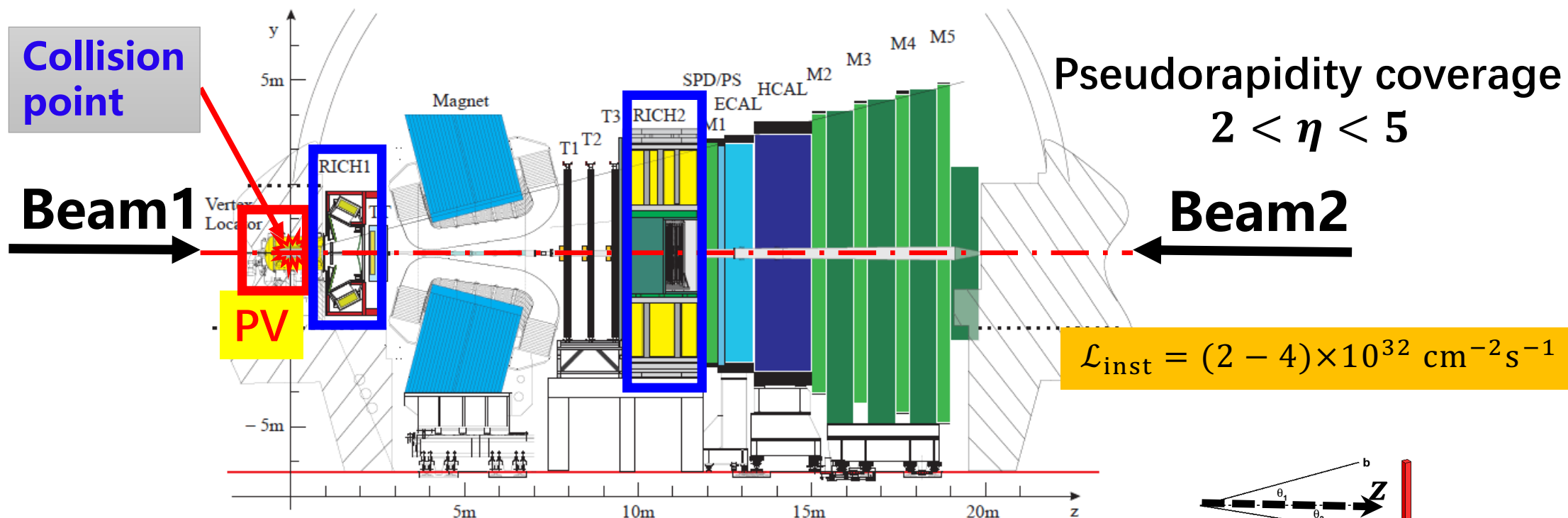
Institute of Atomic Physics, Bucharest-Magurel, Romania
D. Anghel, C. Coca, S. Costache, C. Kusko, D. Lazarovici, H. Petrascu, R. Ruscu

JINR, Dubna, Russia
E.N. Kozarenko, I.E. Kreslo, V. Tyukov

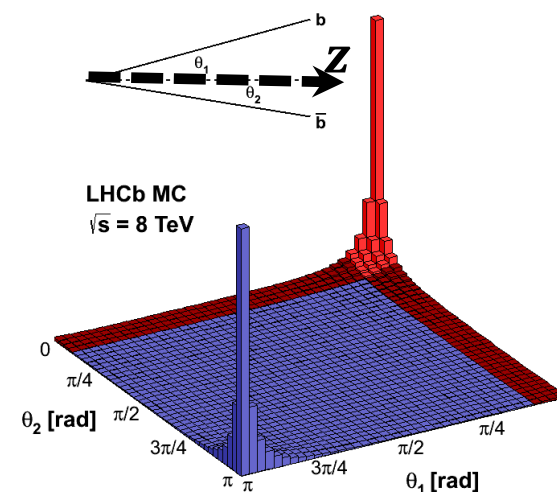
The LHCb detector

JINST 3 (2008) S08005

Int. J. Mod. Phys. A 30 (2015) 1530022

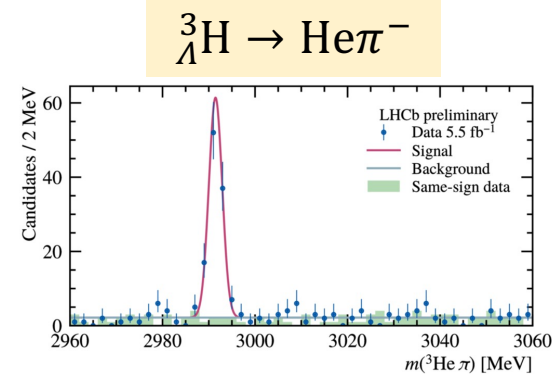
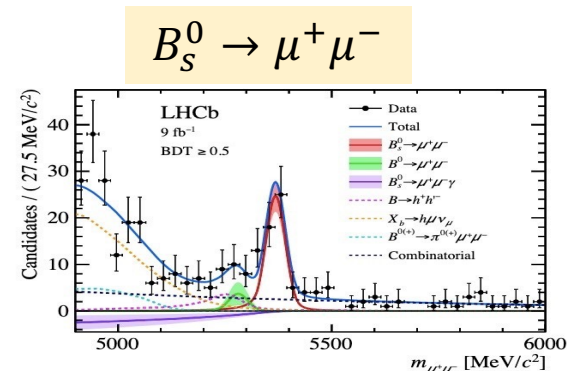
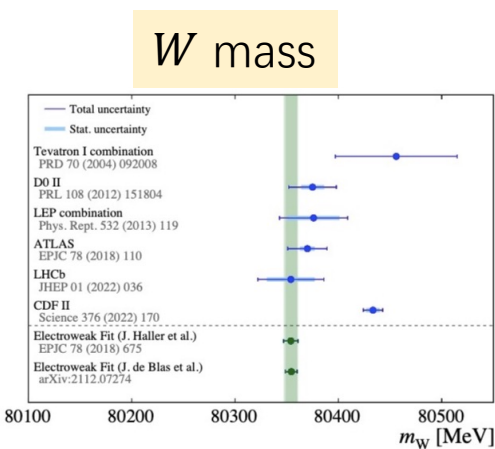
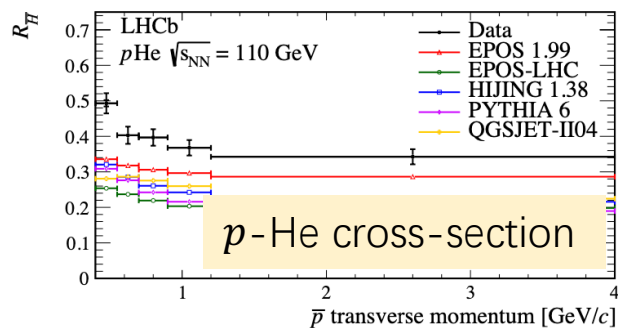


Vertex: $\sigma_{\text{IP}} = 20 \mu\text{m}$
Time: $\sigma_{\tau} = 45 \text{ fs}$ for $B_s^0 \rightarrow J/\psi \phi$ or $D_s^+ \pi^-$
Momentum: $\Delta p/p = 0.4 \sim 0.6\%$ (5 – 100 GeV/c)
Mass : $\sigma_m = 8 \text{ MeV}/c^2$ for $B \rightarrow J/\psi X$ (constrained $m_{J/\psi}$)
Hadron ID: $\varepsilon(K \rightarrow K) \sim 95\%$ mis-ID $\varepsilon(\pi \rightarrow K) \sim 5\%$
Muon ID: $\varepsilon(\mu \rightarrow \mu) \sim 97\%$ mis-ID $\varepsilon(\pi \rightarrow \mu) \sim 1 - 3\%$
ECAL: $\Delta E/E = 1 \oplus 10\%/\sqrt{E} \text{ (GeV)}$

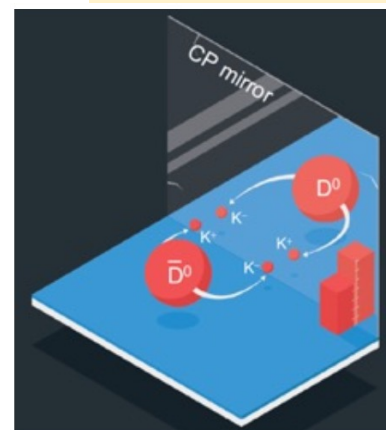


LHCb: a history of success

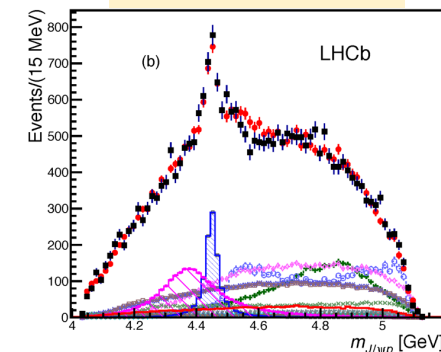
- 686 papers, 52093 citations
- Series of significant discoveries
 - Rare decays
 - CPV in charm and beauty
 - Spectroscopy
- Physics program well beyond designed
 - Fixed-target
 - Heavy-ions
 - Dark sector
 - Electroweak



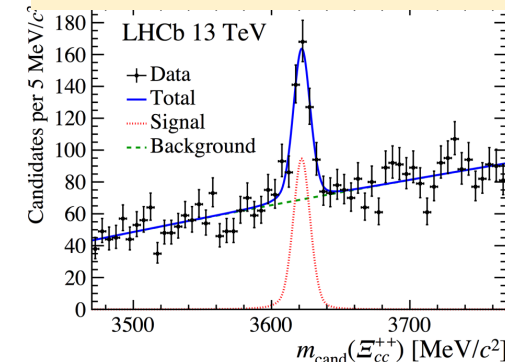
CPV in charm



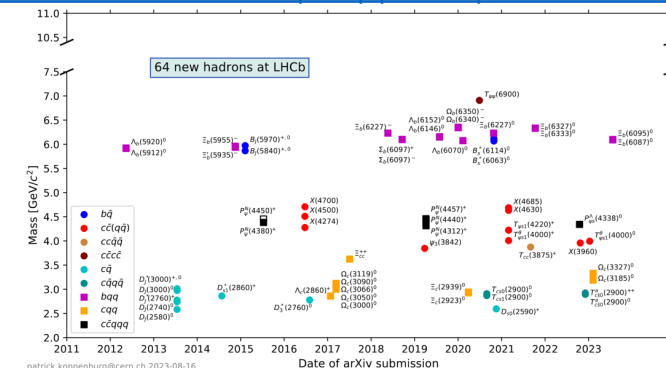
pentaquarks



Doubly-charmed hadron



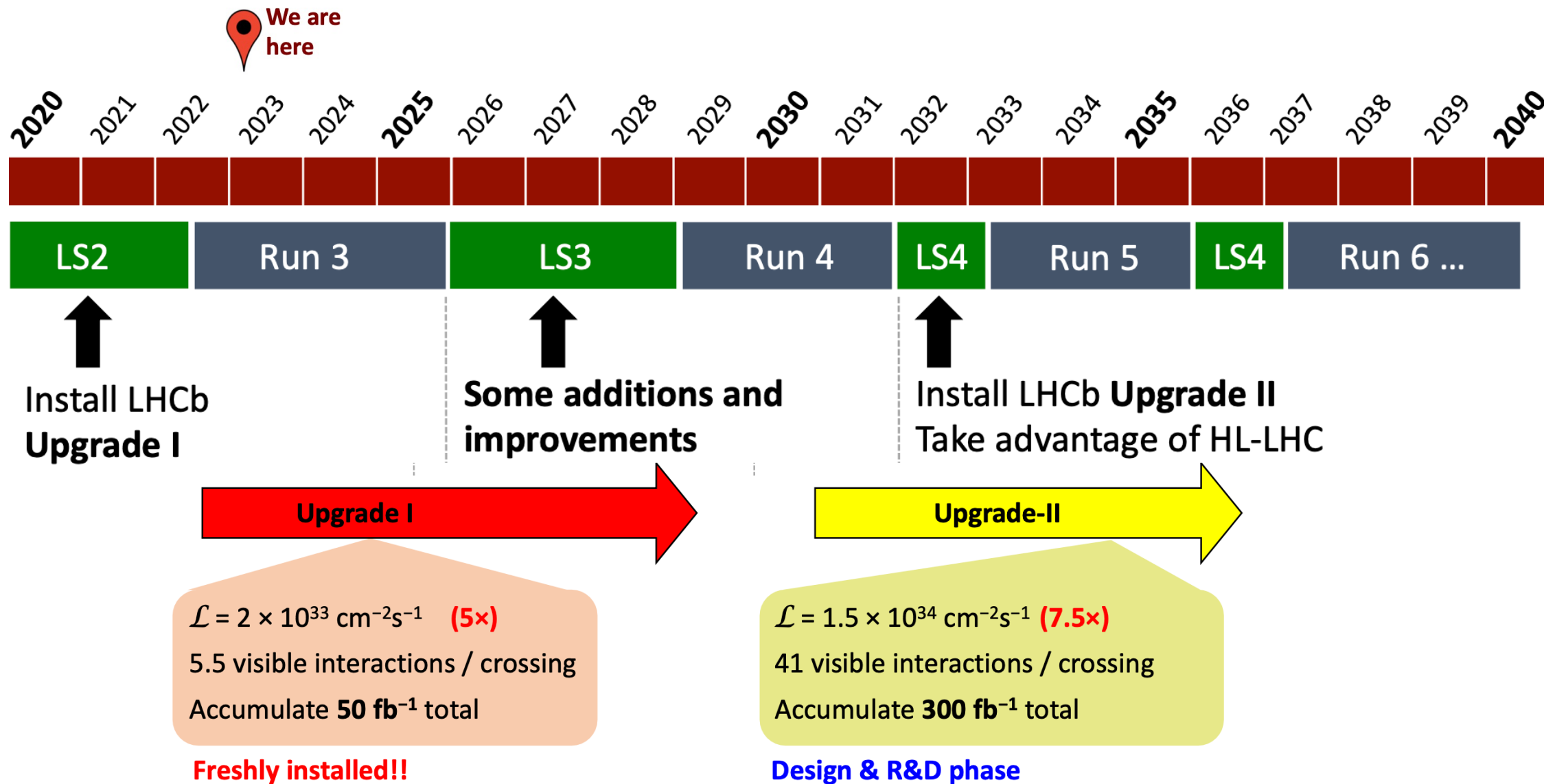
<https://www.nikhef.nl/~pkoppenb/particles.html>



Contents

- Introduction: the past
 - LHCb in Run 1&2
- LHCb Upgrade 1: the present
 - Run 3&4
- LHCb Upgrade II: the future
 - Run 5&6 ...
- Summary

LHCb Upgrades (-2040)



LHCb Upgrade I: motivations

➤ New Physics

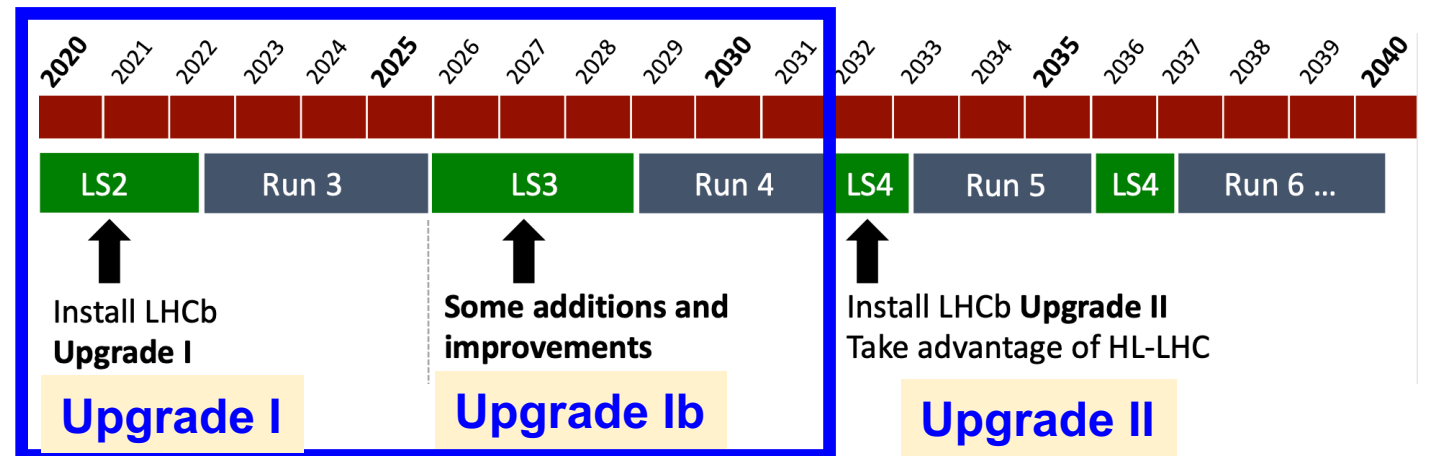
- Flavour physics can probe energy scales well beyond the reach of current and foreseen accelerators

➤ Physics program limited by LHCb instead of the LHC

➤ Necessary to push current measurements down to SM precision

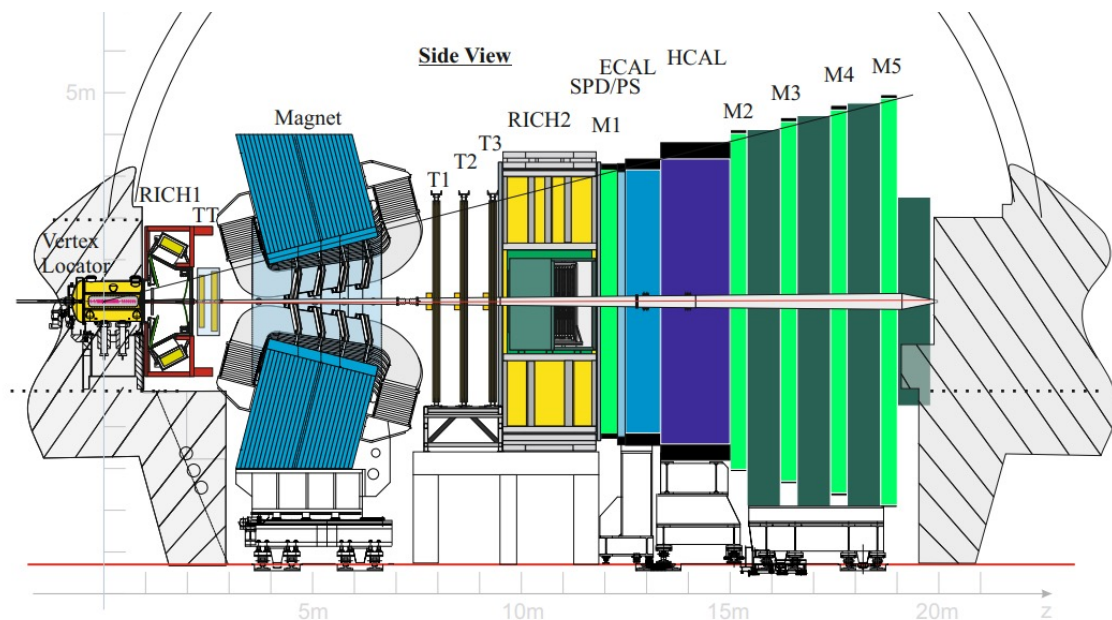
- $\mathcal{B}(B_s^0 \rightarrow \mu^+ \mu^-)$ down to 10% of SM
- CKM angle γ down to 1°
- $2\beta_s$ to precision $< 20\%$ of SM value
- Charm CPV down to 10^{-4}

 **LHCb Upgrade I**

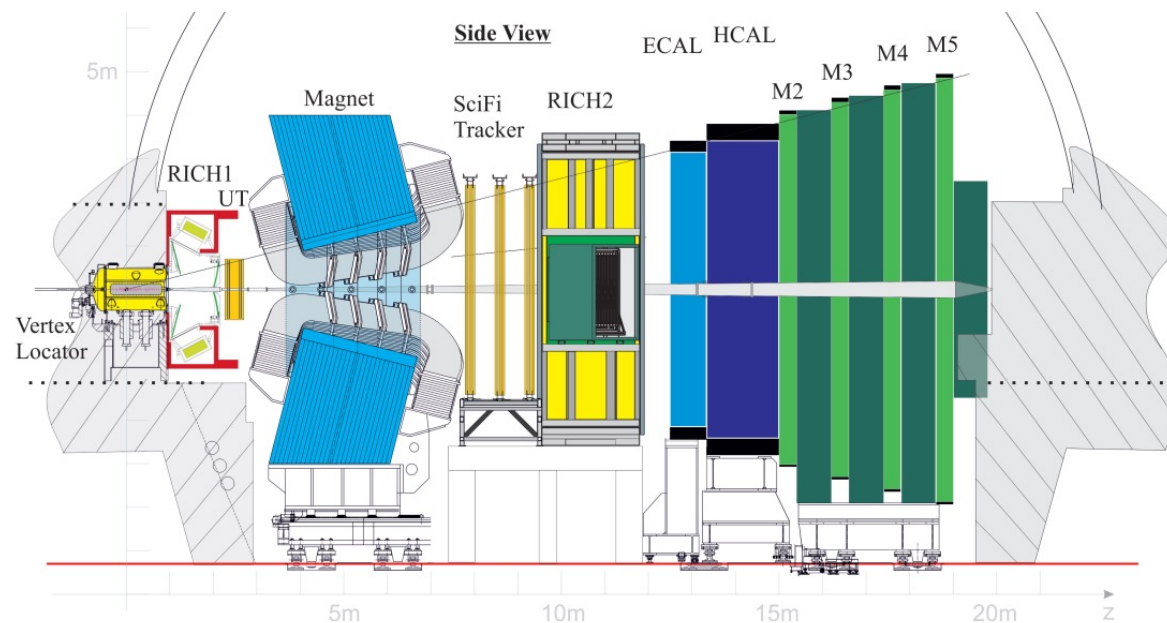


What's the difference?

LHCb



LHCb Upgrade I



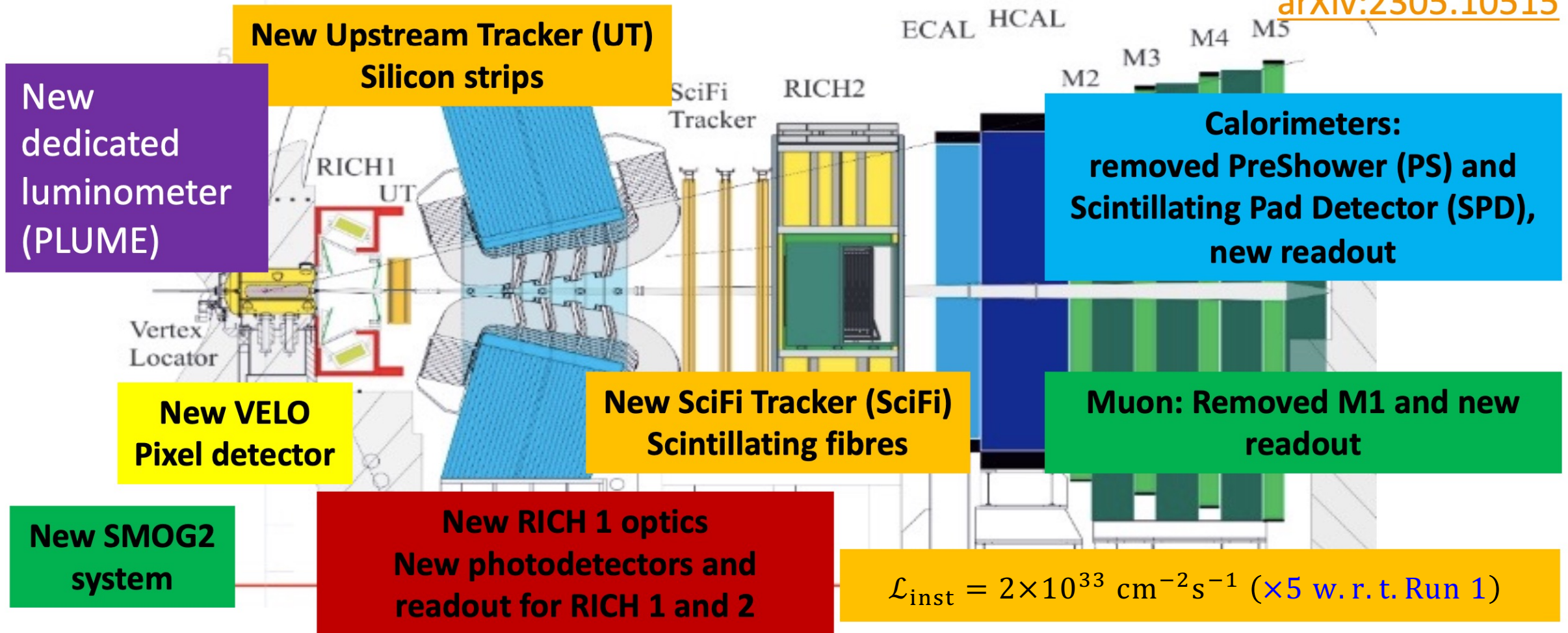
Almost the same?

LHCb Upgrade I: Run 3&4

A brand new detector!

CERN-LHC-2012-007

[arXiv:2305.10515](https://arxiv.org/abs/2305.10515)



LHCb Upgrade I: Run 3&4 (cont.)

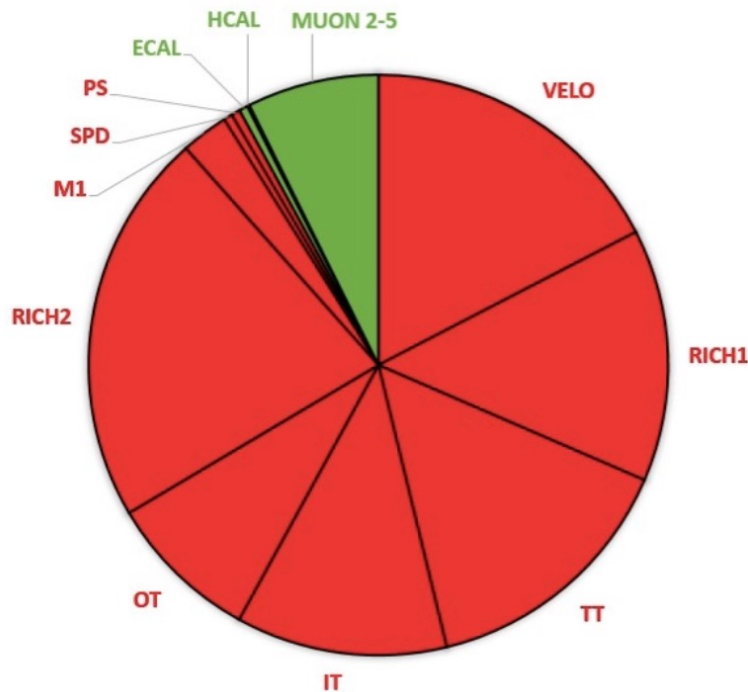
A brand new detector!

CERN-LHCC-2012-007
arXiv:2305.10515

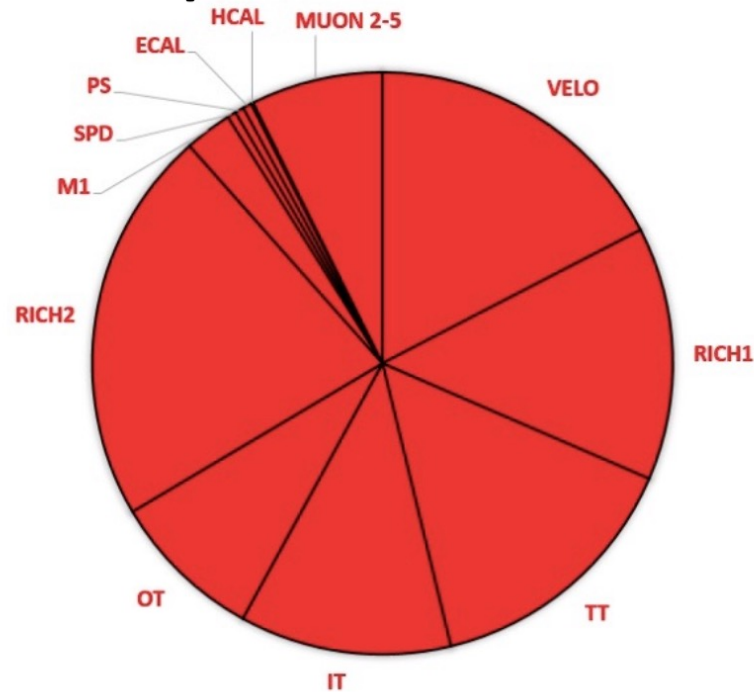
To be upgraded

To be kept

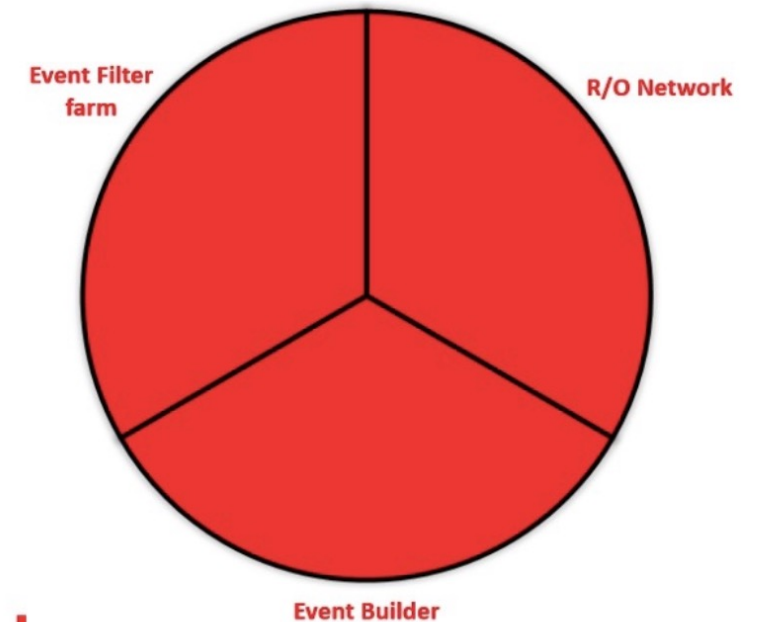
Detector channels



R/O electronics



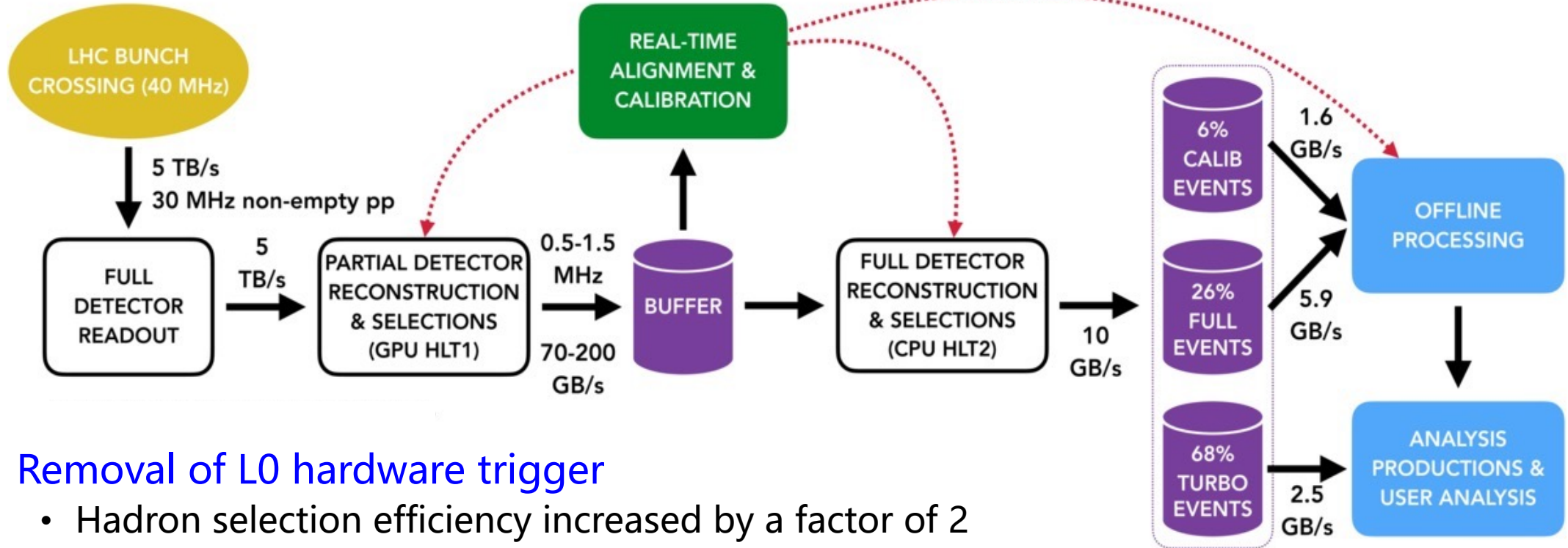
DAQ



a BIG upgrade for LHCb

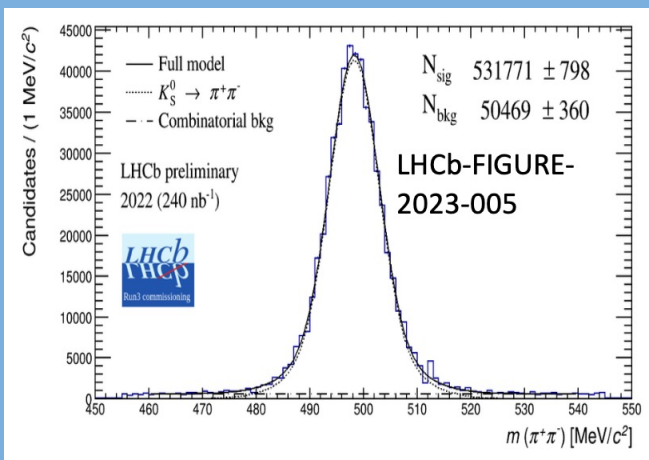
LHCb Upgrade I: Data processing and trigger

CERN-LHCC-2018-007

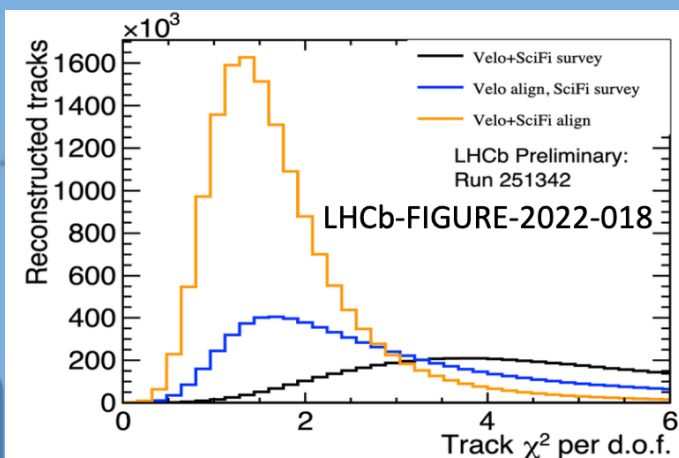


- Removal of L0 hardware trigger
 - Hadron selection efficiency increased by a factor of 2
- HLT1 reconstruction on GPUs
- Real time alignment and calibration
- Offline quality reconstruction in HLT2

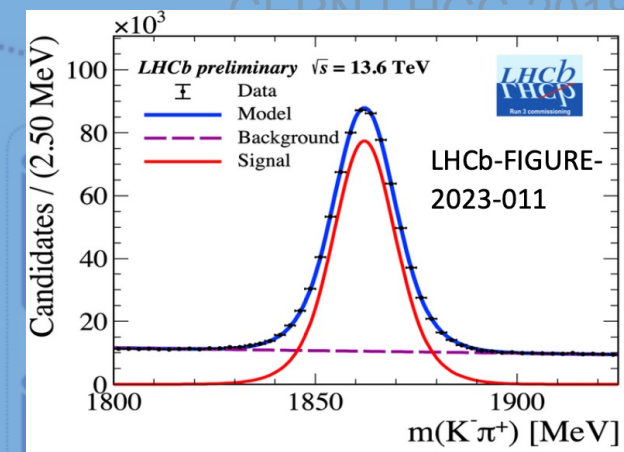
LHCb Upgrade I: Data processing and trigger (cont.)



K_S^0 candidates directly by HLT1



Improvements of distribution of χ^2/ndof for long tracks after alignment

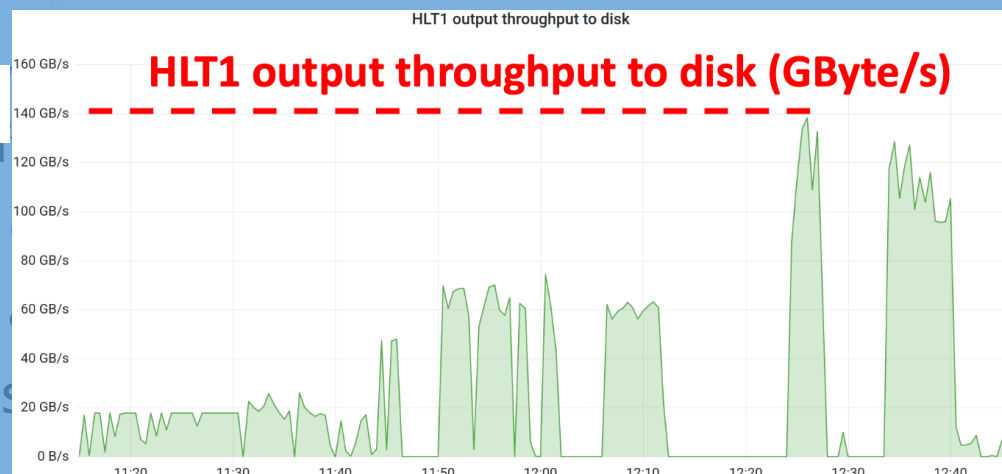


D^0 candidates by HLT2

- Removal of LHCb Upgrade I
- Hadron selection
- HLT1 reconstruction
- Real time alignment
- Offline quality recon

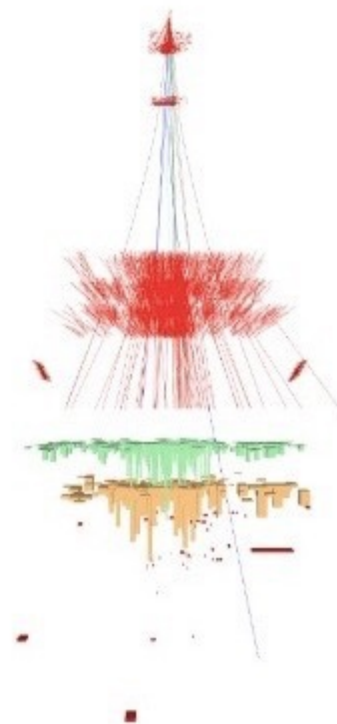
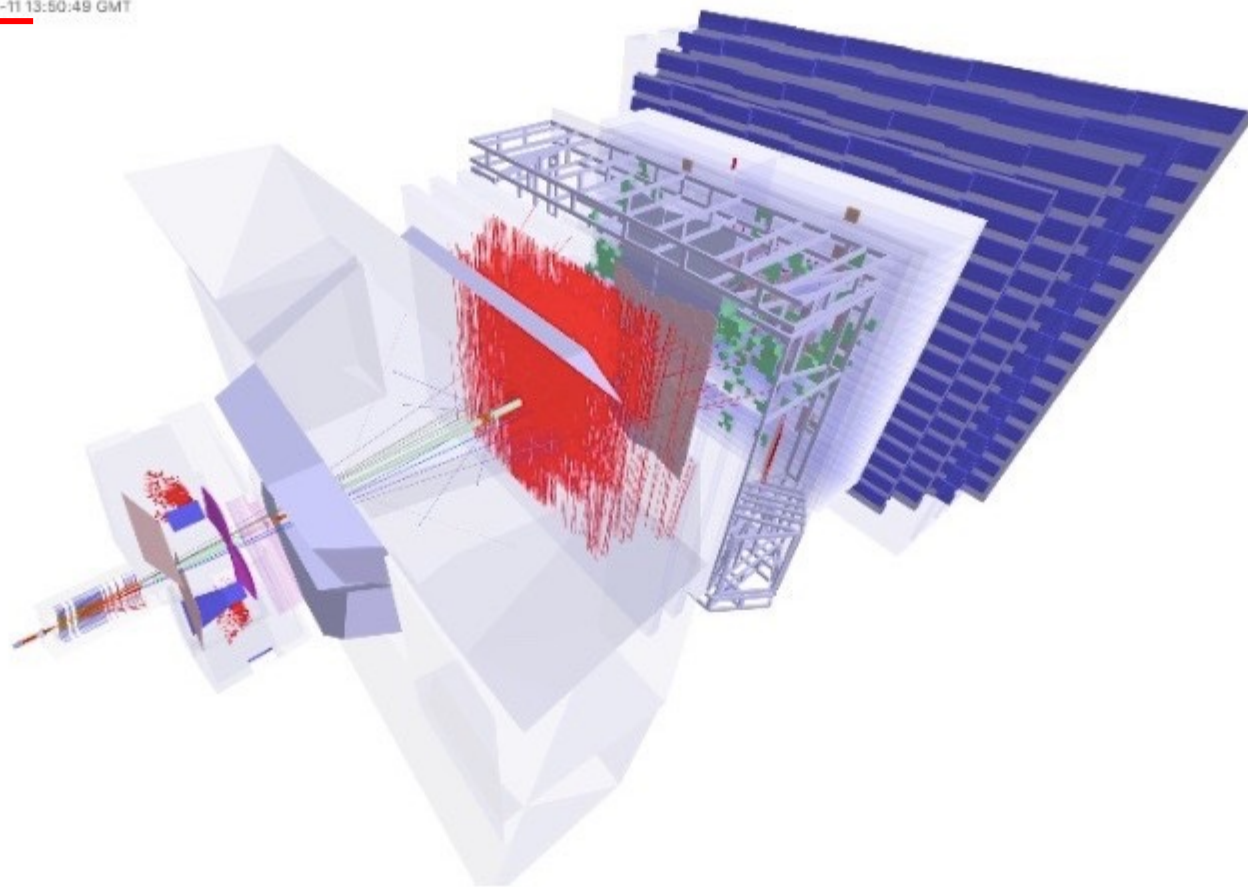
140 GB/s

HLT1 output throughput to disk (GByte/s)

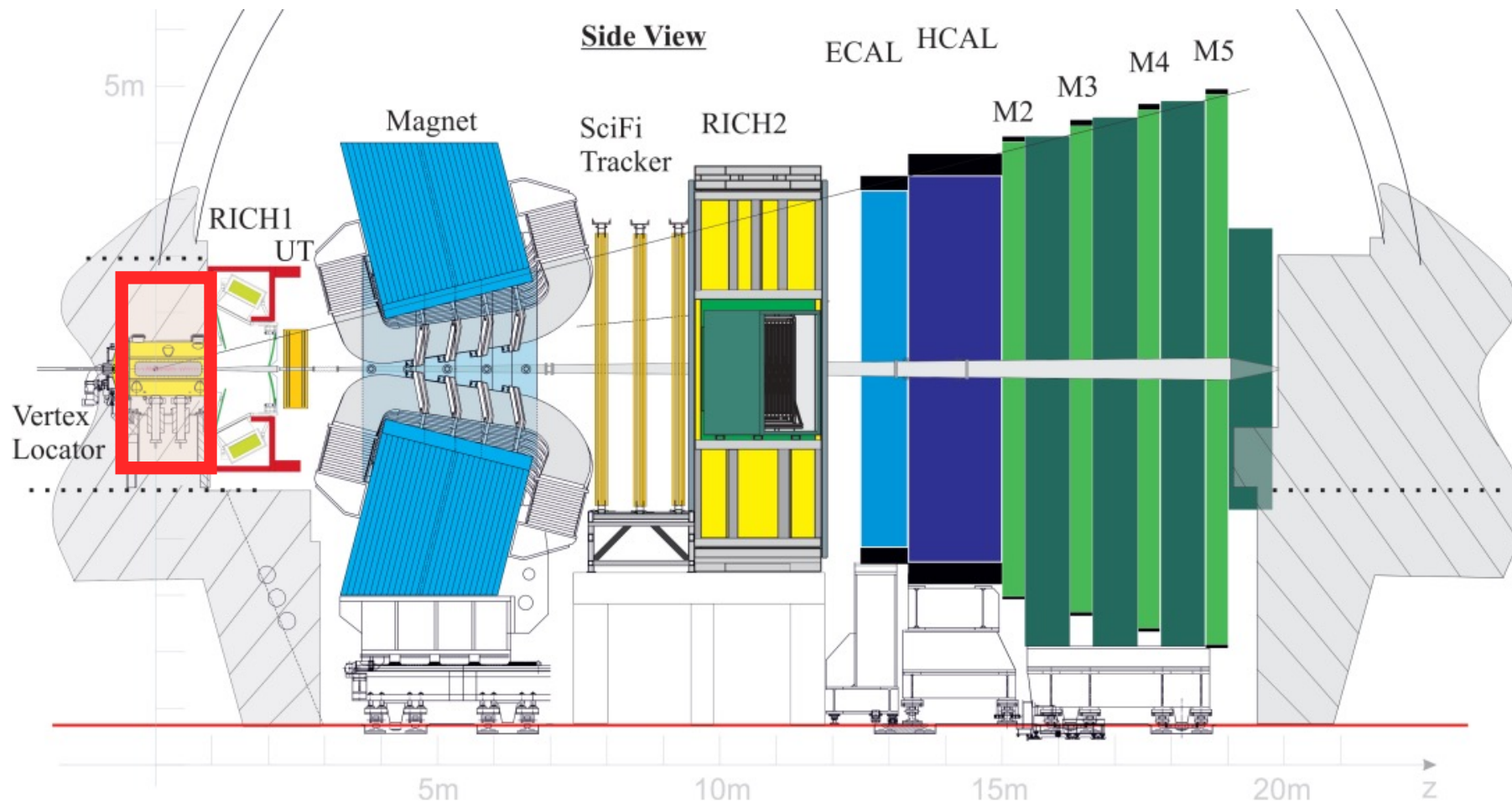


Event display at 2023: Run 3

LHCb Experiment at CERN
Run / Event: 263132 / 5940637
Data recorded: 2023-05-11 13:50:49 GMT



LHCb Upgrade I: VELO



Silicon micro-strip



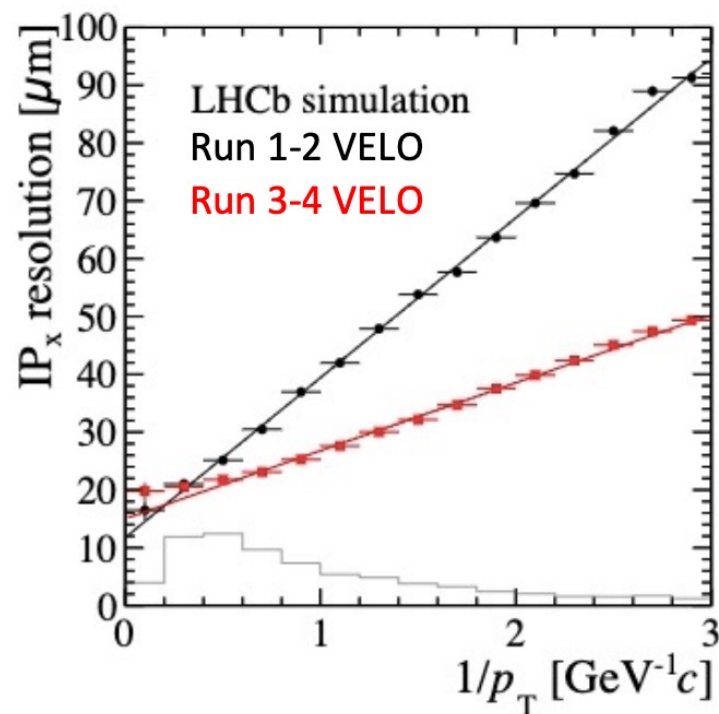
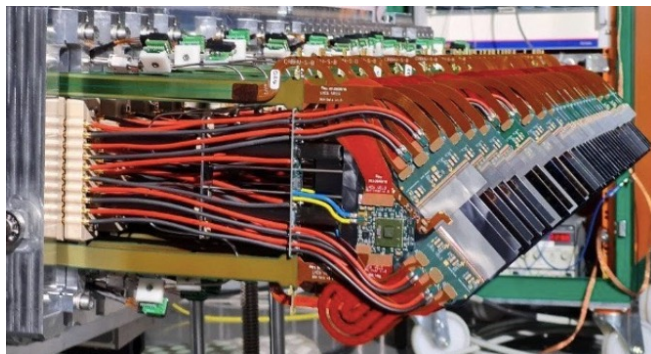
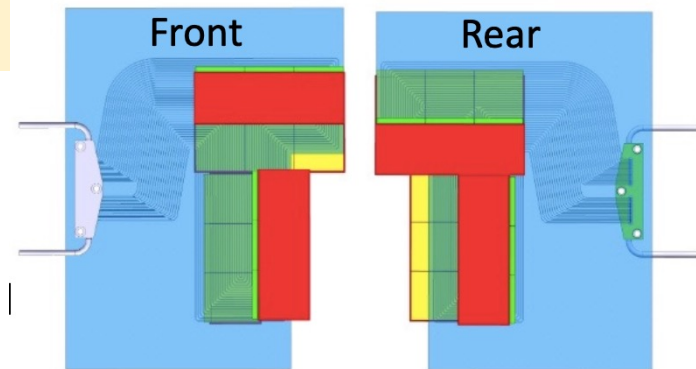
Silicon pixel

LHCb Upgrade I: VELO

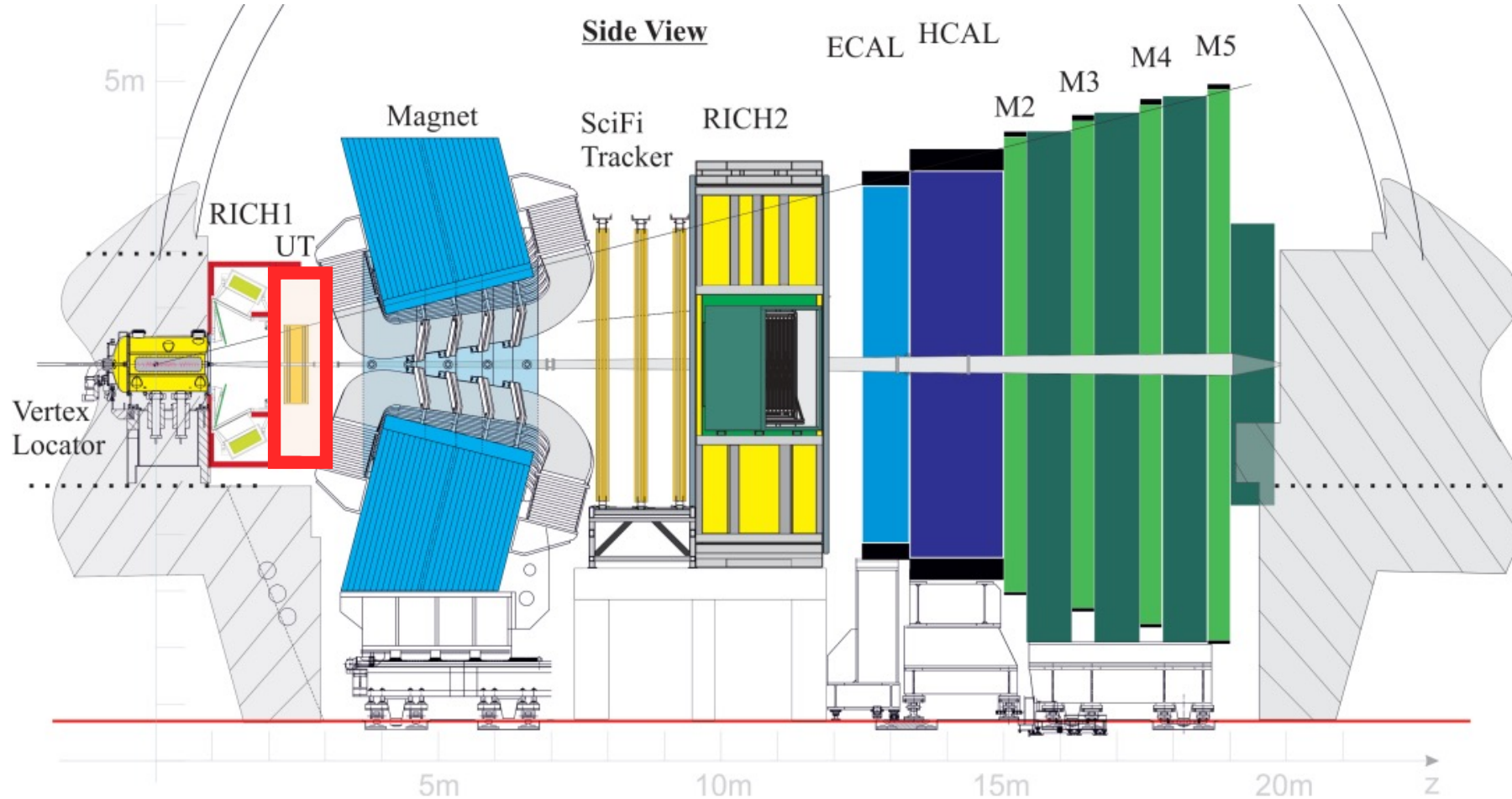
CERN-LHCC-2013-021

- 52 modules for a total of 41M pixels
 - Area: 1.2 m²
- Two movable halves → as close as 3.5 mm to the beam to improve σ_{IP}
 - Separation from primary vacuum achieved with 150 μ m thick RF foil
- Silicon substrate with micro channels carrying CO₂ for evaporative cooling
 - Designed to cool a load of up to 30W from each module
- New ASIC VeloPix, ~20 Gbit/s in hottest ASIC and total of ~2 Tbit/s

Silicon pixel detector



LHCb Upgrade I: Upstream Tracker (UT)



Silicon micro-strip



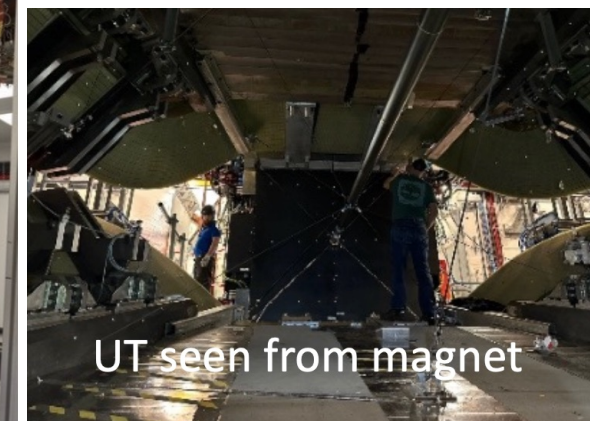
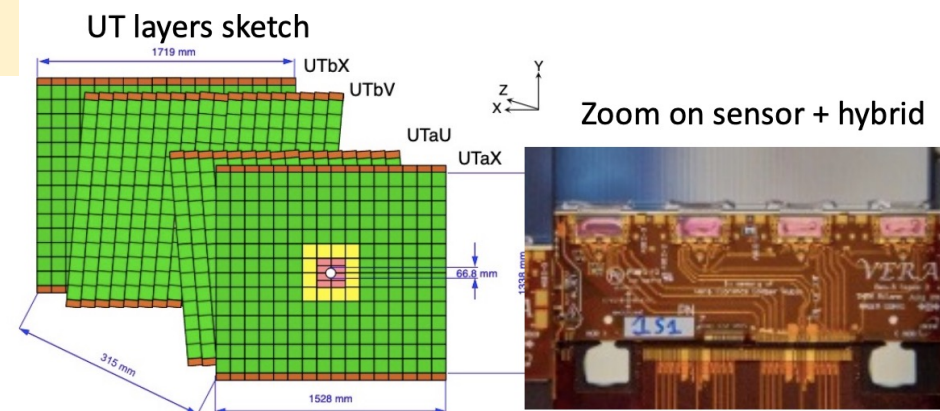
Silicon micro-strip, but ...

LHCb Upgrade I: UT

CERN-LHCC-2014-001

Silicon micro-strip detector

- Two layers → four layers (aX,aU,bV,bX)
- Increasing granularity getting closer to beam
- Different sensors for different regions
 - 250 μm thickness
 - Pitch: $\sim 95 - 190 \mu\text{m}$
 - Sensors mounted on staves (both sides)
 - Maximum occupancy: $< 1\%$
- Sensors need to be kept below -5°C
 - Bi-phase CO_2 cooling pipe integrated in stave
- UT installed before cavern closure in 2023
→ commissioning ongoing!

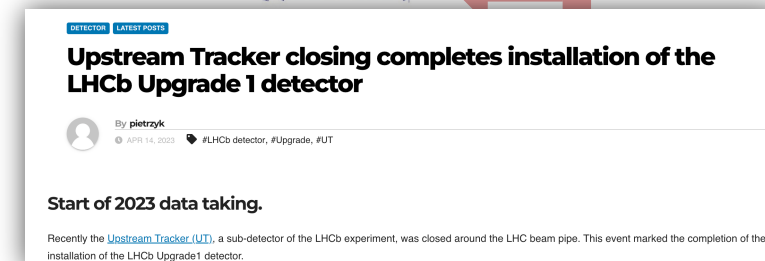
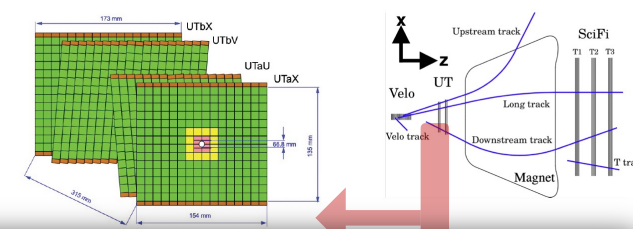


Upgrade I: UT at China

Chinese groups contributed to **UT installation**, ensuring LHCb Upgrade I completion in time (IHEP/HNU/CCNU/THU/SCNU/LZU)



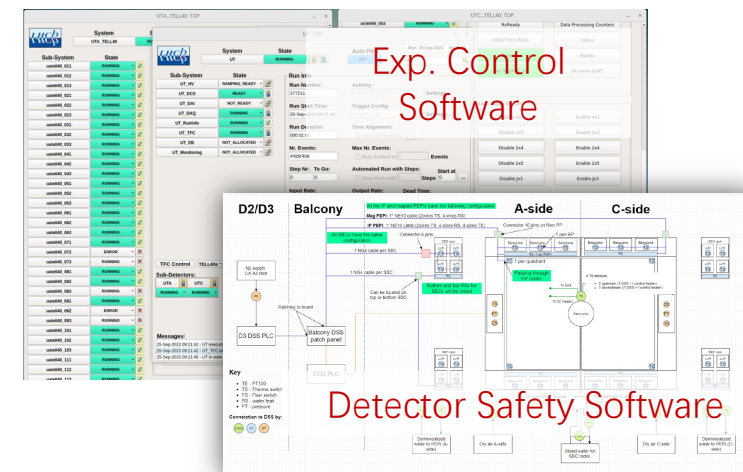
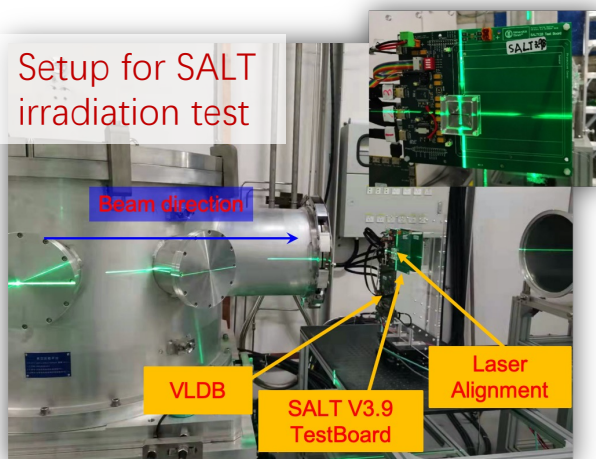
Completion of: a stave / A-side / C-side



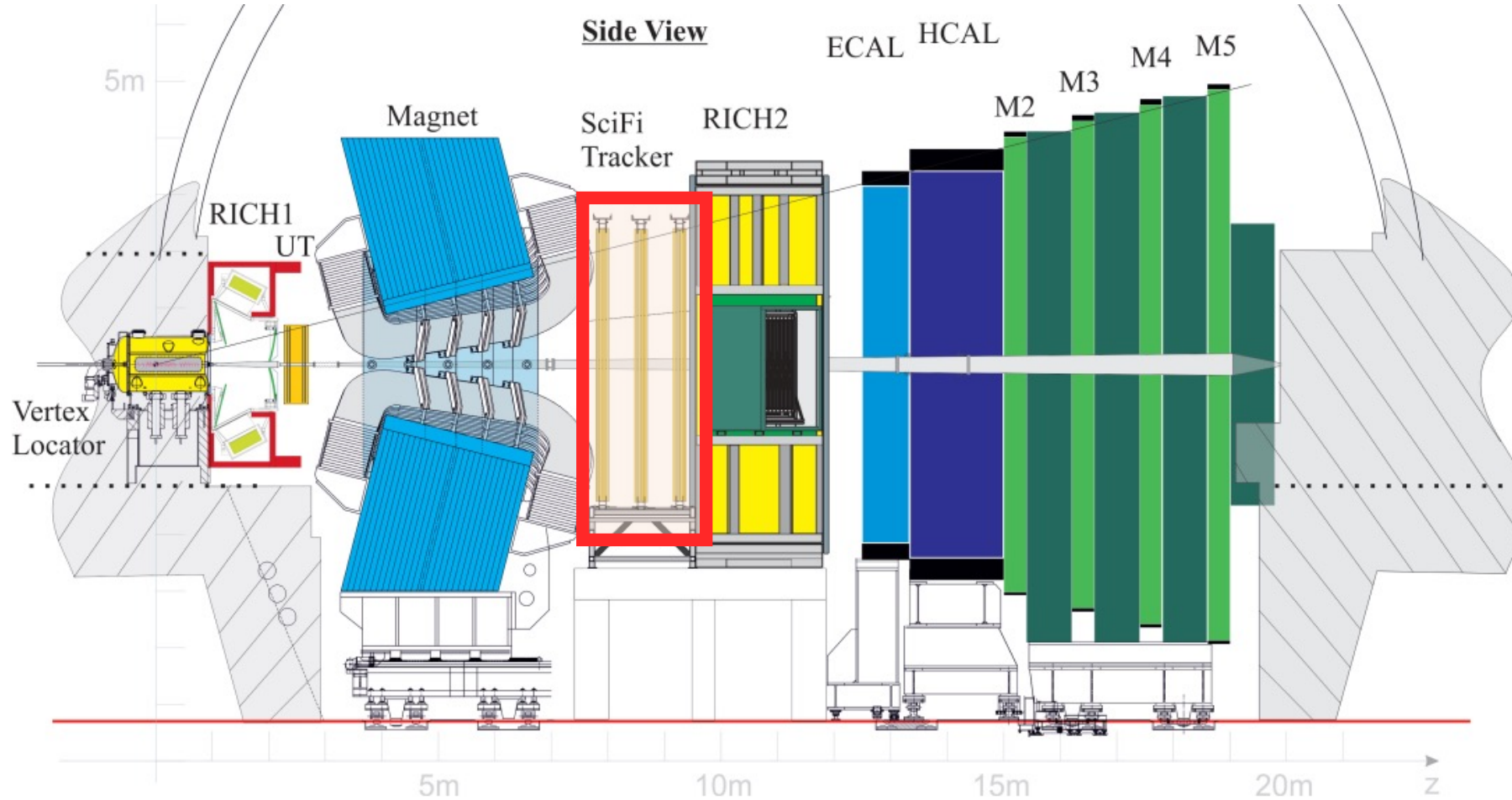
Lead development in control and safety monitoring software (IHEP)

Performed **key radiation tests for SALT chip** using **Chinese facilities** during pandemic (IHEP/HNU)

Setup for SALT irradiation test



LHCb Upgrade I: Scintillating fibres tracker (SciFi)



straw-tube drift chambers+Silicon micro-strip



Scintillating fibres tracker

LHCb Upgrade I: SciFi

CERN-LHCC-2014-001

➤ Brand new detector with scintillating fibres

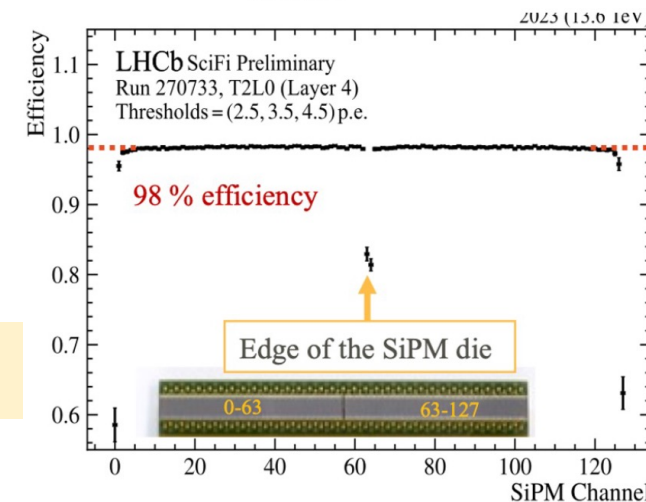
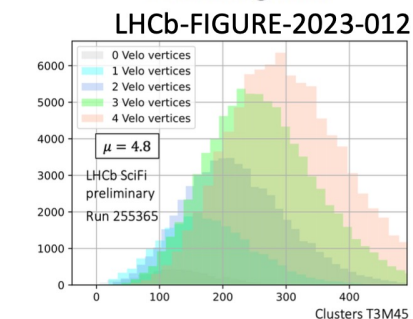
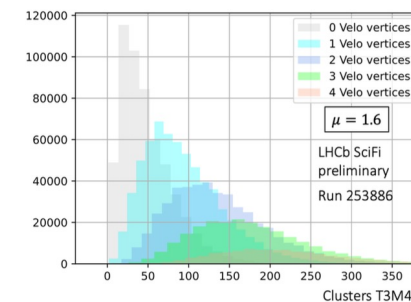
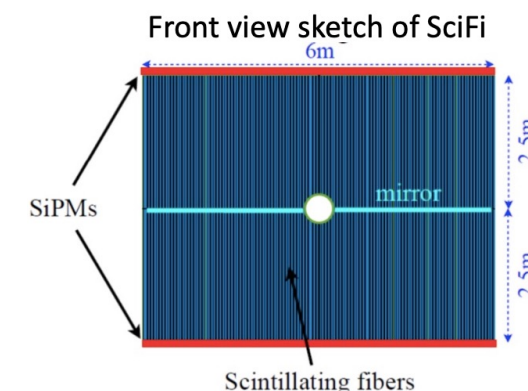
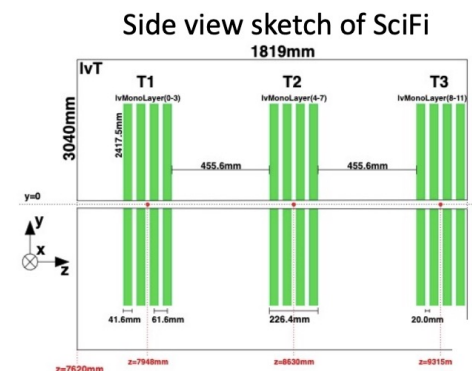
- Three stations with four detection layers each, 6 fibres / layer
- Fibres diameter and length: 250 μm / 2.4 m
- Decay-time constant: 2.8 ns
- Produced in total 12000 km of fibres

➤ Light detected by SiPMs installed at one end of the fibres

- Temperature -40°C to reduce dark counts

➤ New ASIC, 64 channels 130 nm CMOS

- Clusterisation of hits implemented in FPGA after signal digitisation



LHCb FIGURE-2023-021

Good performance in 2023

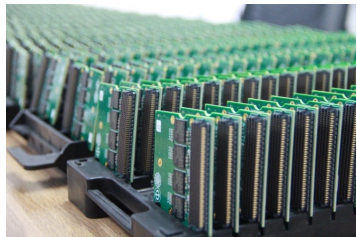
LHCb Upgrade I: SciFi at China



QA System for readout ASICs & the Front-End Board

SciFi: 524,000 SiPM channels

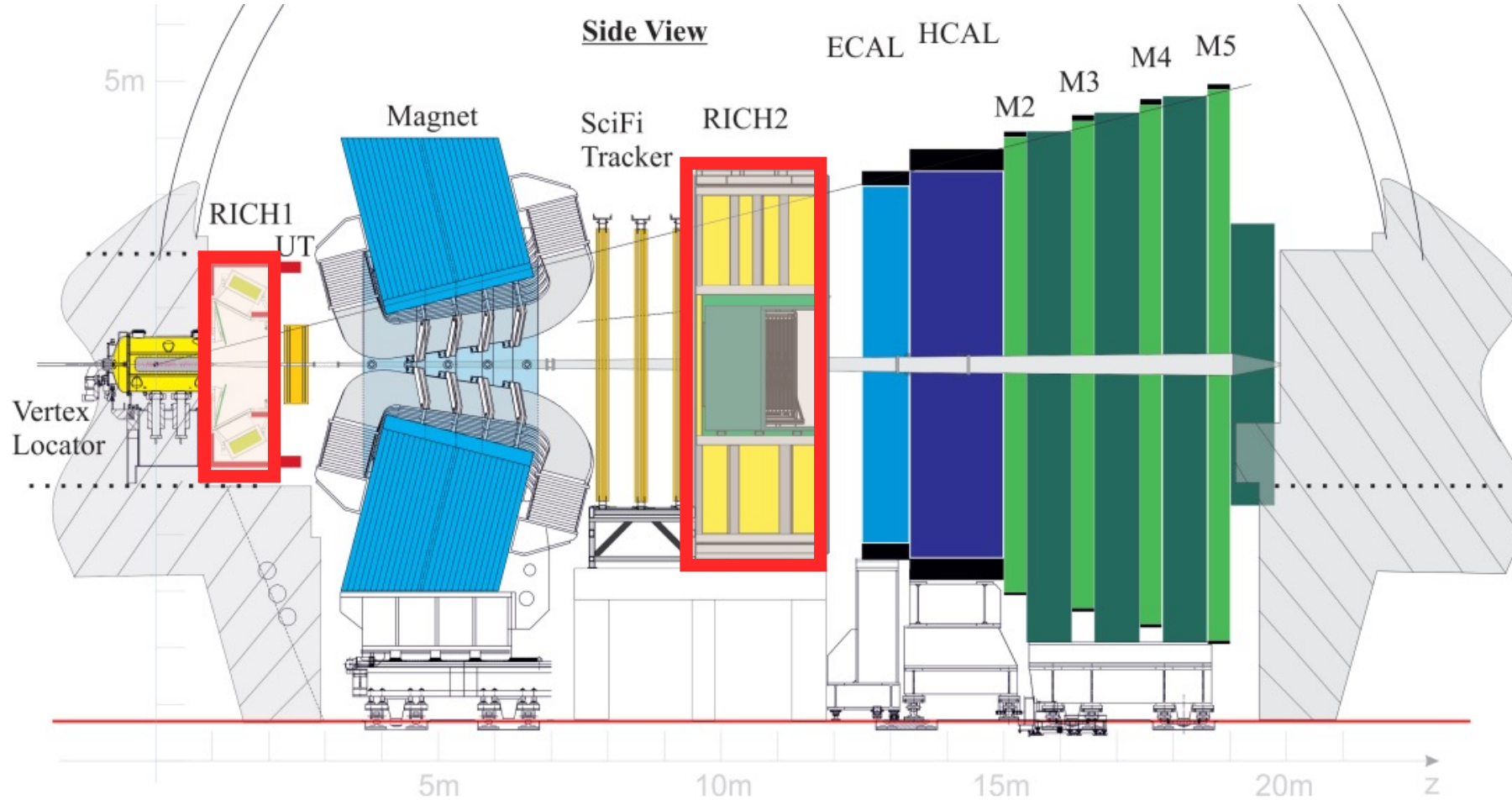
SciFi readout ASIC (PACIFIC): a 64-channel SiPM readout



- LHCb SciFi China Group (Tsinghua U):
 - **Co-design** the ASIC Frontend Board (with Heidelberg)
 - **Manufacture all 2,528 ASIC Boards** (64,168 channels in total)
 - **Test 1/2 of ASIC Boards and all the chips**
 - **11 setups of Quality Assurance System for ASICs & boards for LHCb**



LHCb Upgrade I: Rich 1&2



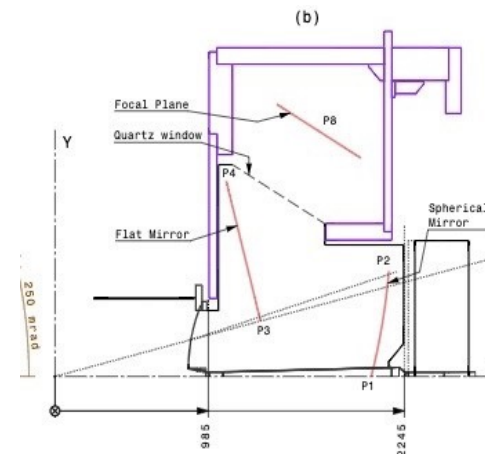
New optics, new PMTs, new readout

LHCb Upgrade I: RICH 1&2

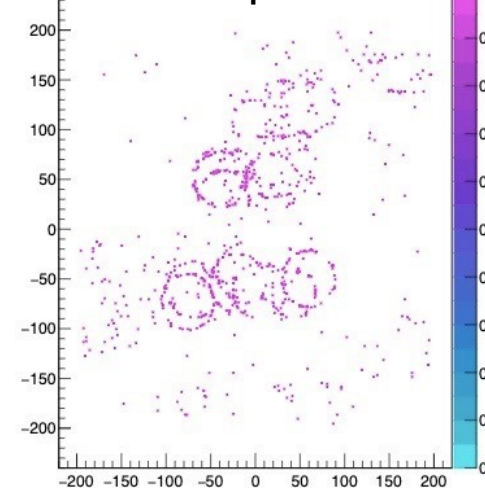
CERN-LHCC-2013-022

Scheme of new mirrors setup

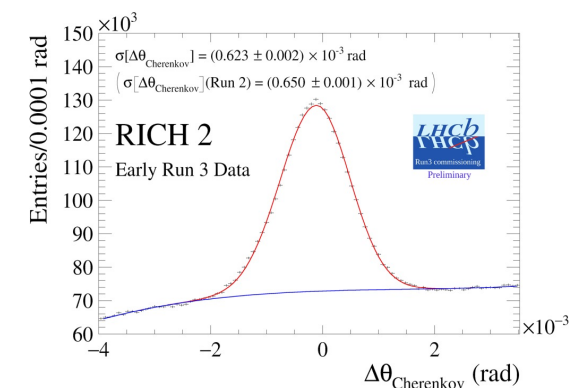
- Preserve excellent performance in Run 1&2
 - RICH1 with C_4F_{10} and RICH2 with CF_4
 - PID for momenta between 2.6 and 100 GeV/c
- Replace Hybrid Photon Detectors (HPDs) with Multianode PMTs in RICH1&2
 - 26.2 or 52 mm² area with 64 pixels
- Change curvature of RICH1 spherical mirrors to reduce occupancy on PMTs
 - factor 2 less
- New radiation hard and fast readout ASIC developed (CLARO)
- RICH 1&2 performance already better than in Run 1&2!



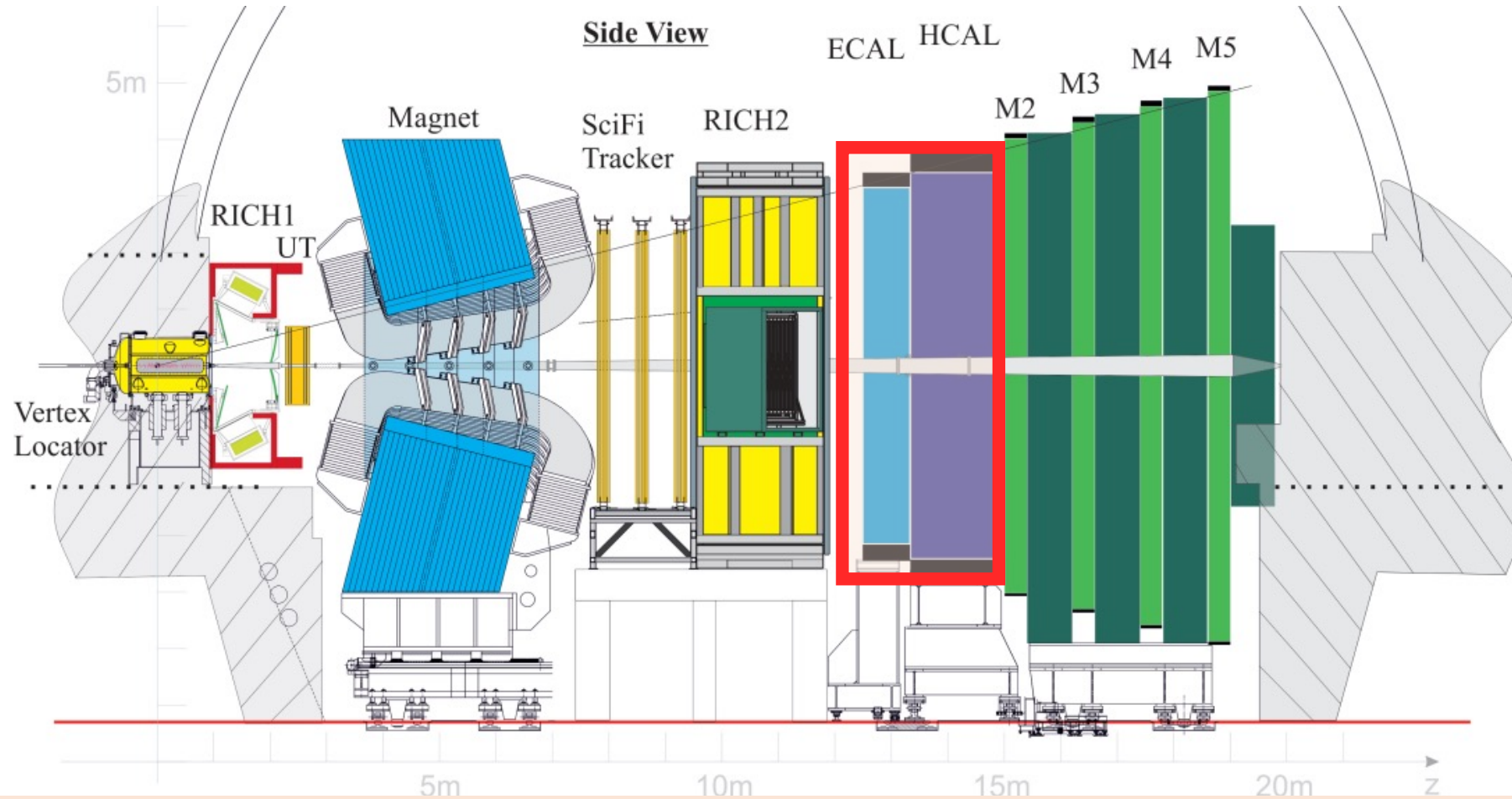
RICH1 - Run 259596 eventID 927492
RICH1 hitmap from 2023



LHCb-FIGURE-2023-007



LHCb Upgrade I: ECAL&HCAL



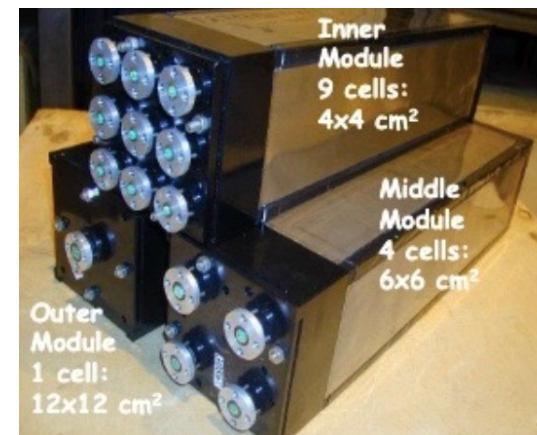
new readout, Preshower (PS) and Scintillating pad detector (SPD) removed

LHCb Upgrade I: ECAL&HCAL

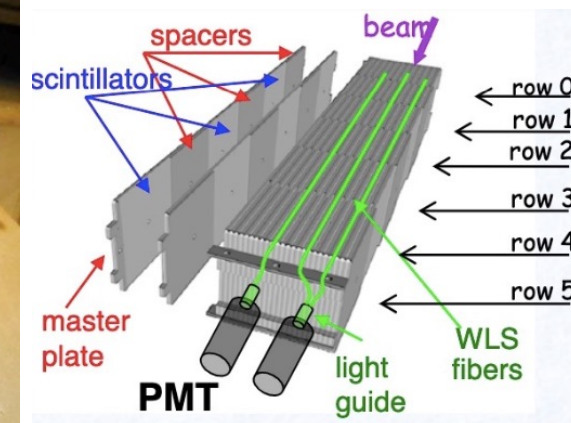
CERN-LHCC-2013-022

- Present detector kept unchanged
 - ECAL: Shashlik modules (lead + scintillator) for a total of $25X_0$
 - HCAL: TileCal modules (iron + scintillator)
- PS/SPD detectors removed
 - No need for fast inputs to L0 hardware trigger
- PMT gain reduced by a factor 5 to increase lifetime of detector
 - Compensated by an equal increase in the electronic amplifier gain
- Front-End electronics redeveloped
 - Trigger-less readout
 - Cope with increased instantaneous luminosity
- Some ECAL inner modules will be replaced already in LS3 to test Upgrade II prototypes in Run 4

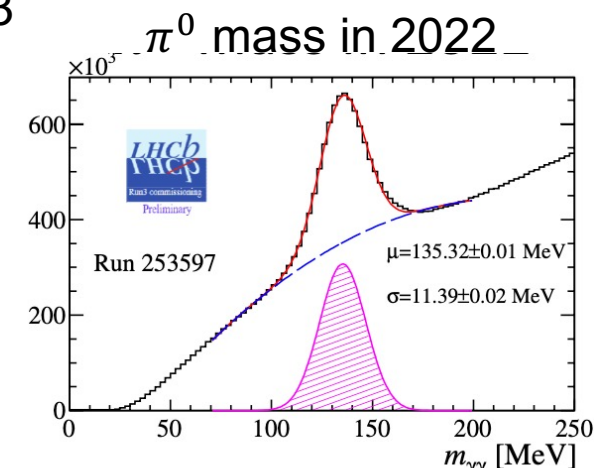
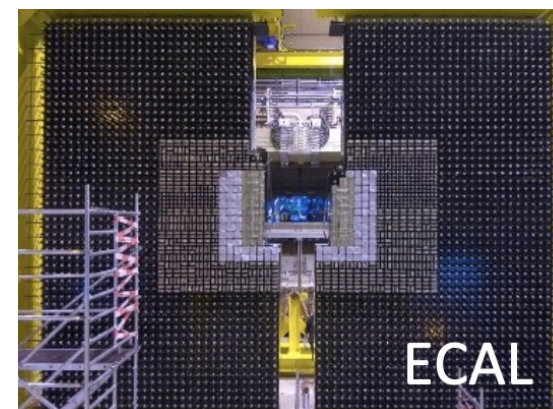
Shashlik modules



HCAL module

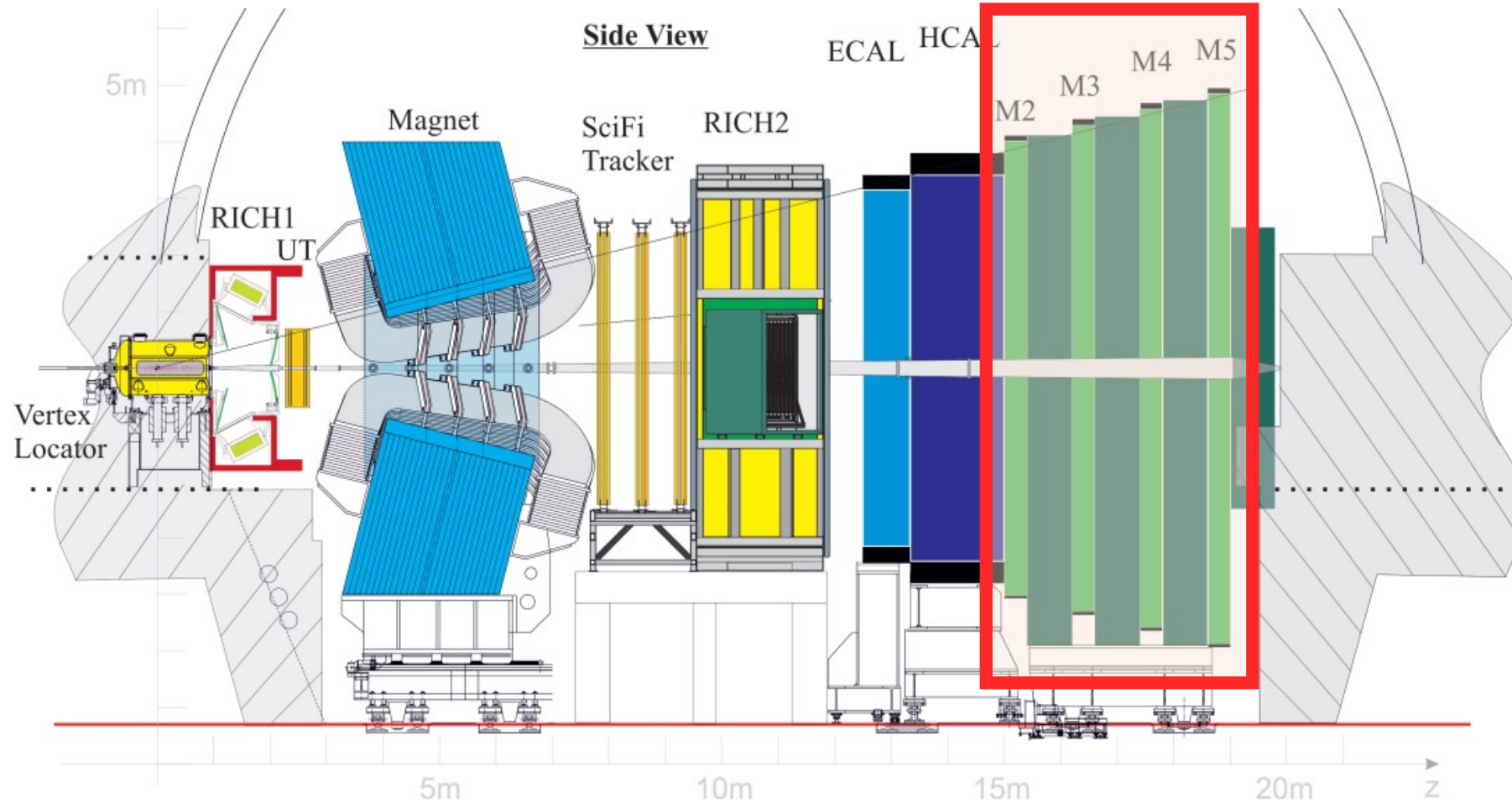


RICH1 hitmap from 2023



LHCb-FIGURE-2022-019

LHCb Upgrade I: MUON

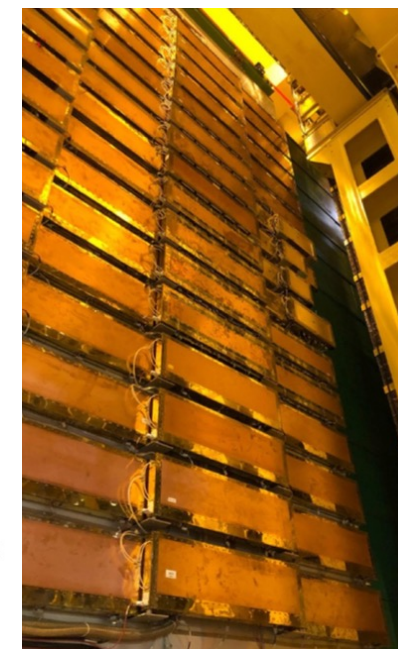
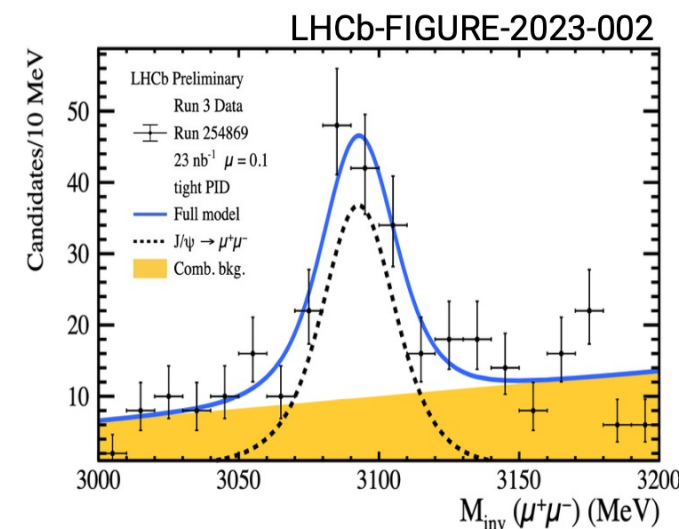
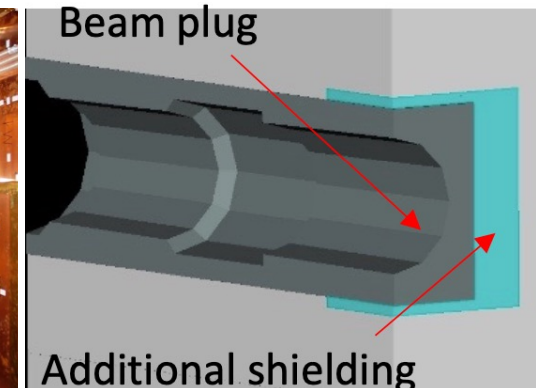


new readout, M1 removed

LHCb Upgrade I: MUON

CERN-LHCC-2013-022

- Remove first layer (M1) with GEMs of present MUON detector
 - since L0 trigger level has been removed
 - The 4 layers (M2-M5) of Multi-Wire Proportional Chambers (MWPCs)
- Install additional shielding around beampipe
 - reduce particle flux in M2 inner region
- Redesign electronics to cope with 40 MHz trigger-less readout
- R&D to replace inner parts of M2 and M3 with more granular detectors (triple GEMs/MWPCs)

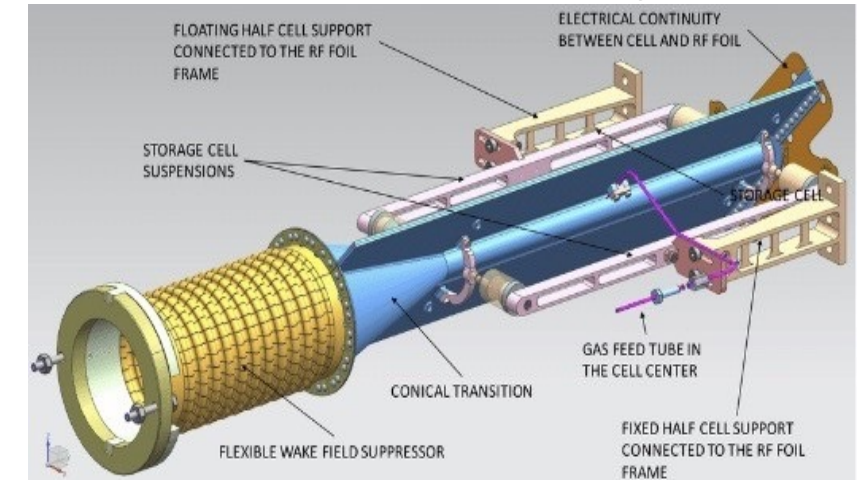


LHCb Upgrade I: SMOG2

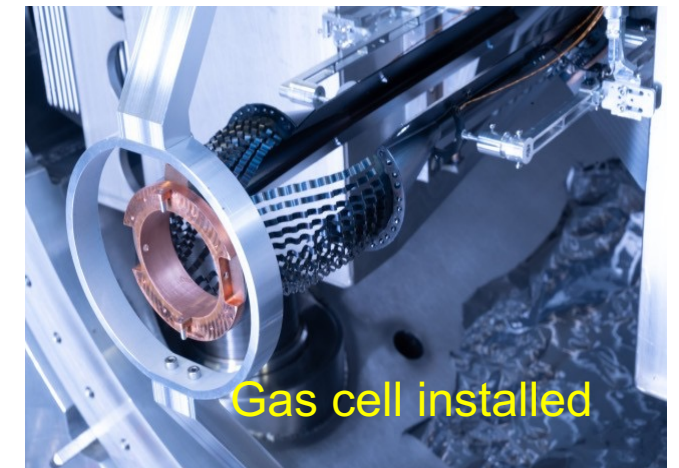
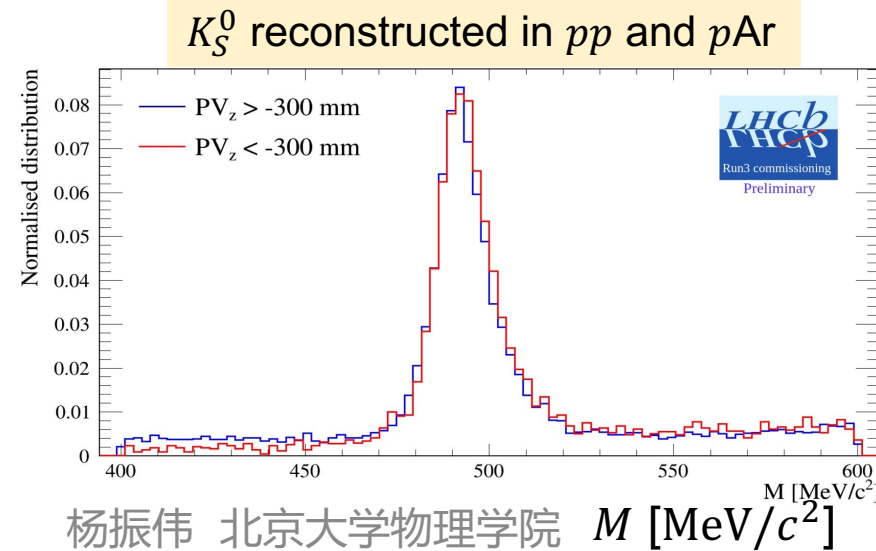
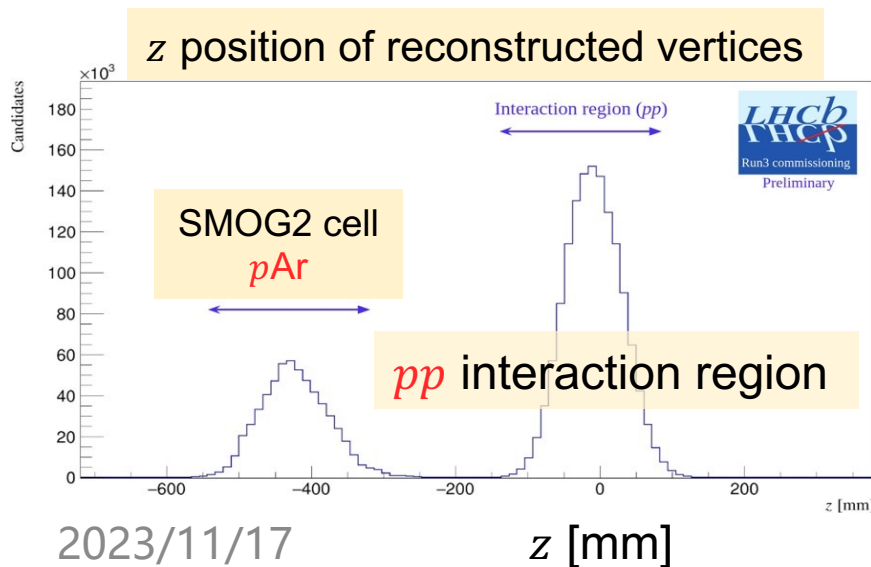
CERN-LHCC-2019-005

- Allows to inject different gases in LHCb IP
 - Fixed-target physics, in parallel with pp data taking
 - Gas cell upstream of VELO $\rightarrow$ pp and p -gas vertices easily distinguishable
- Increase interaction rate by orders of magnitude compared with previous SMOG
 - 20-100 times of collected sample size

Sketch of the gas cell



Shashlik modules

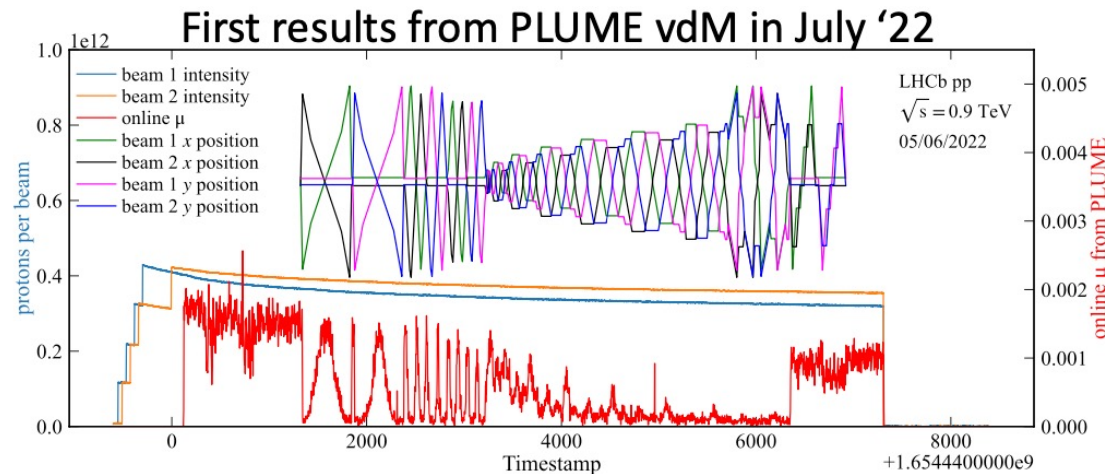
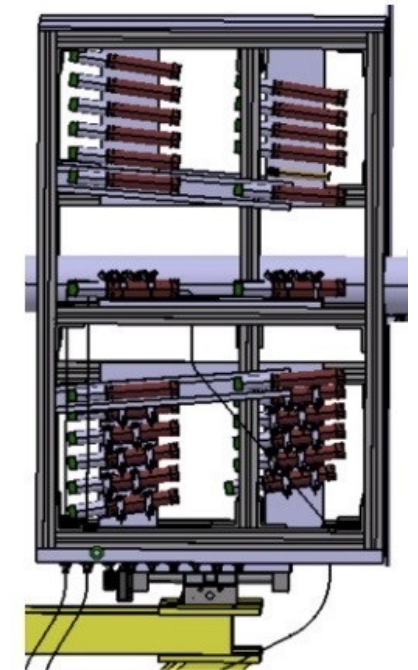


LHCb Upgrade I: PLUME

CERN-LHCC-2021-002

- Cross-shaped hodoscope composed by 48 PMTs, installed upstream of the VELO
 - Detect Cherenkov light from particles impinging on a quartz tablet glued to the PMTs window
- Measure rate of coincidences every 3 sec and compute lumi with logZero method
 - Provide real-time feedback to the LHC to level the luminosity at IP8

Lateral view sketch



Contents

➤ Introduction: the past

- LHCb in Run 1&2

➤ LHCb Upgrade 1: the present

- Run 3&4

➤ LHCb Upgrade II: the future

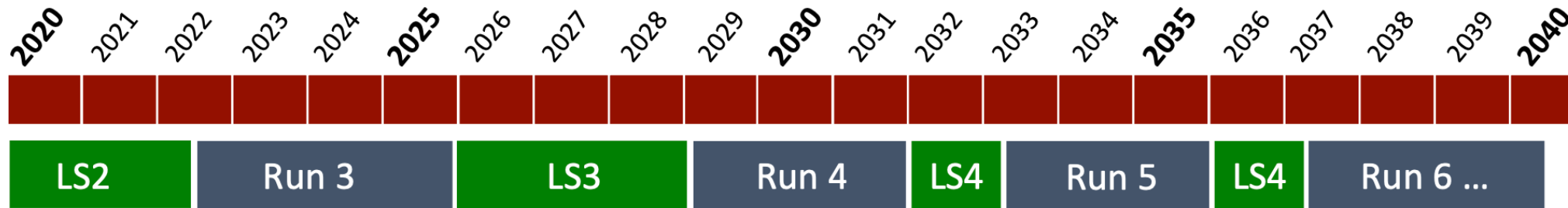
- Run 5&6...

To fully exploit potential
provided by HL-LHC

- **Upgrade Ib**: partly upgrade central parts of ECAL, SciFi, et al
- **Upgrade II**: fully upgrade

➤ Summary

Challenges



$\mathcal{L} = 2 \times 10^{33} \text{ cm}^{-2}\text{s}^{-1}$ (5x)
 5.5 visible interactions / crossing
 Accumulate **50 fb⁻¹** total

Freshly installed!!



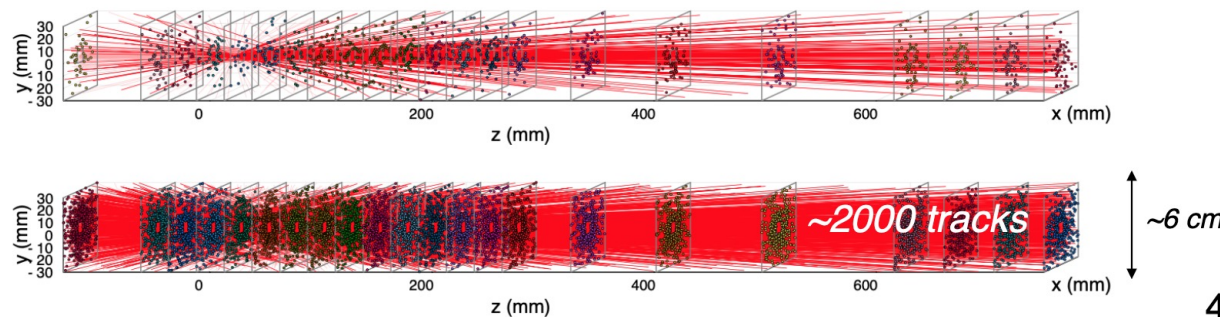
$\mathcal{L} = 1.5 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$ (7.5x)
 41 visible interactions / crossing
 Accumulate **300 fb⁻¹** total

Design & R&D phase

Vertex LOcator (VELO)

Run 3: pile-up ~6

Upgrade II: pile-up ~40



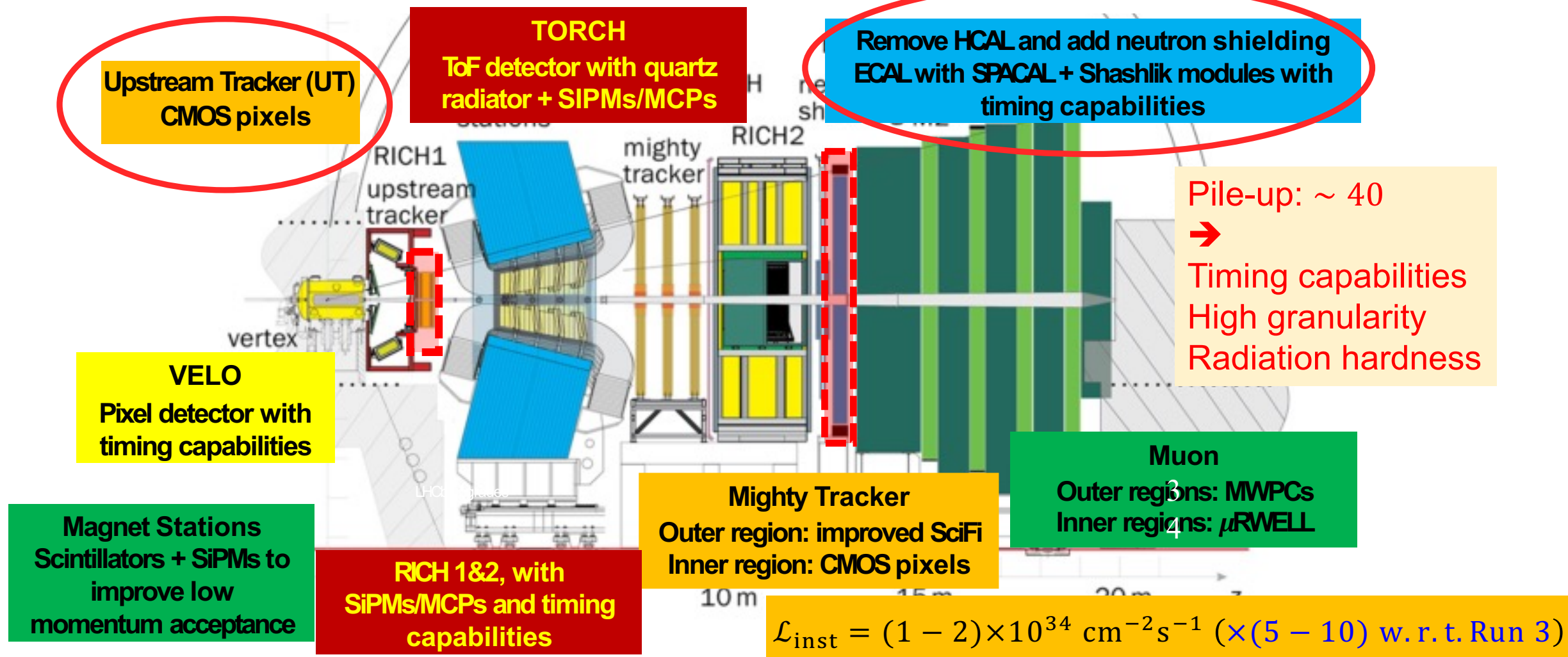
High pile-ups
Radiation hardness

...

LHCb Upgrade II: a plan for Run 5&6

CERN-LHCC-2021-012

The ultimate flavour physics experiment at the HL-LHC



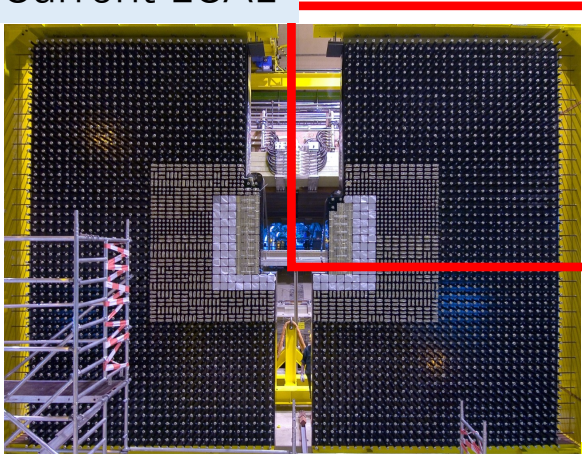
LHCb Upgrade Ib+II at China: ECAL

➤ Requirement: to operate up to $\mathcal{L} = 1.5 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$

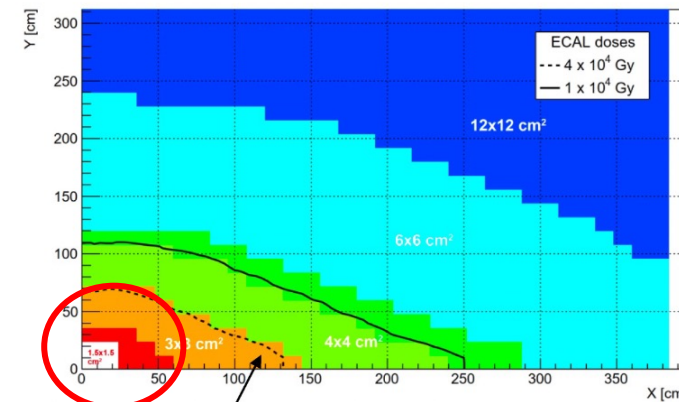
- Keep current energy resolution: $\sigma(E)/E \approx 10\%/\sqrt{E} \oplus 1\%$
- Sustain radiation doses up to 1 MGy
- Mitigate high occupancy and pile-up

High granularity
Time resolution of $\mathcal{O}(10)$ ps

Current ECAL



New layout for Ib/II



Radiation limit of current Shashlik technology

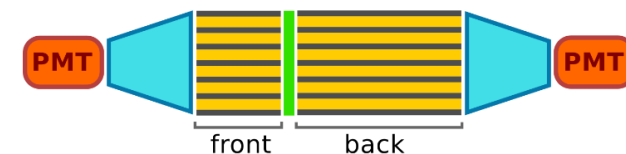
Inner region

Spaghetti Calorimeter (SPACAL)

SPACAL-W (tungsten)
for the most inner region

Side view

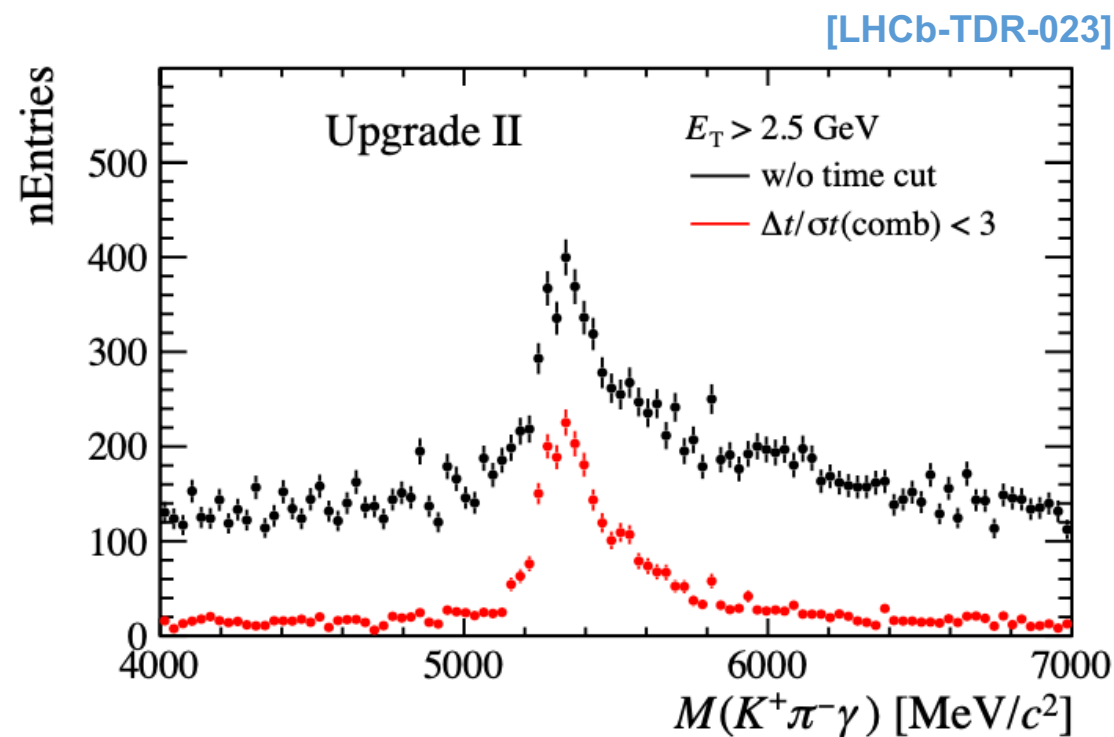
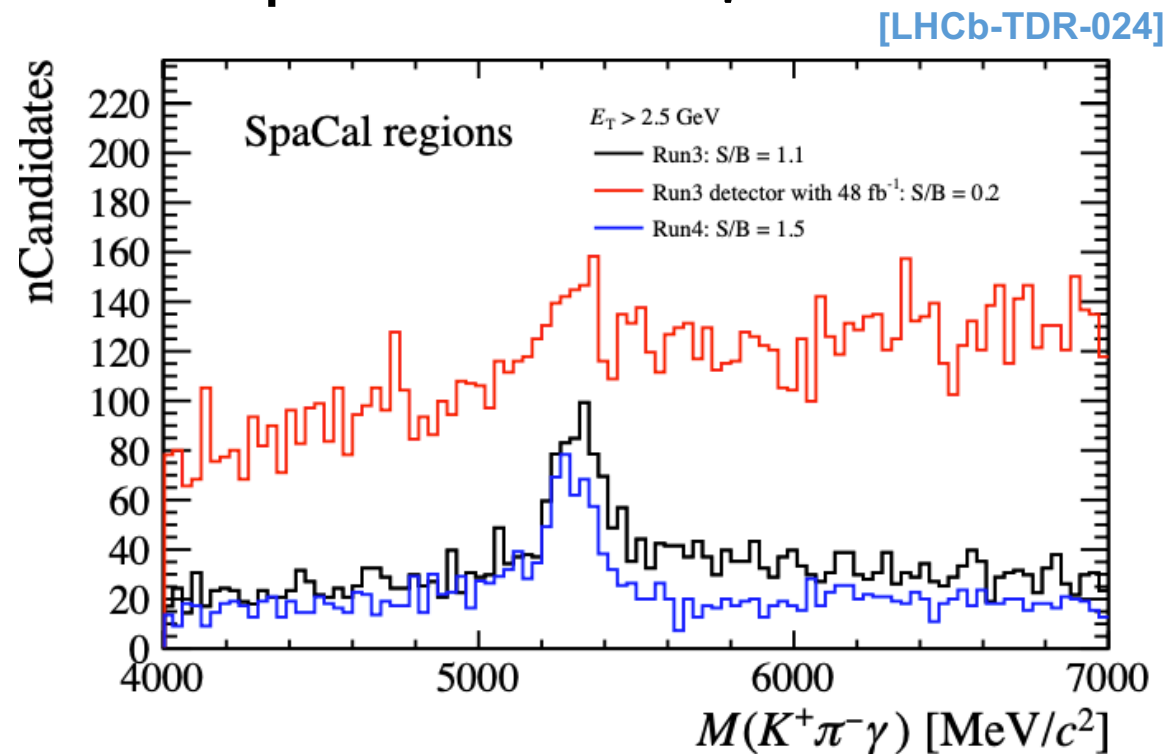
scintillator mirror
absorber light guide



Beam direction

Physical benchmarking simulation

➤ Example: $B^0 \rightarrow K^{*0} \gamma$

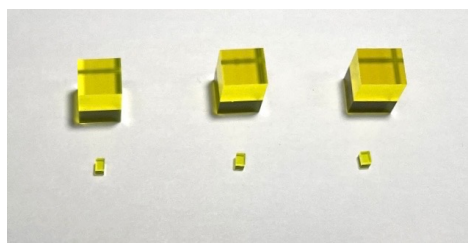
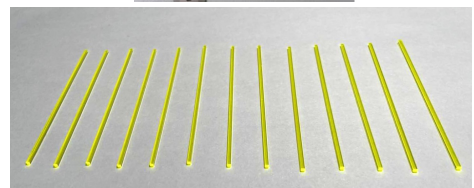
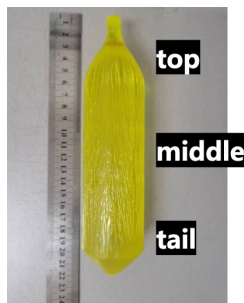


- Upgrade Ib ECAL has better performance than current ECAL
- Time resolution $\mathcal{O}(10)$ ps important to suppress the background

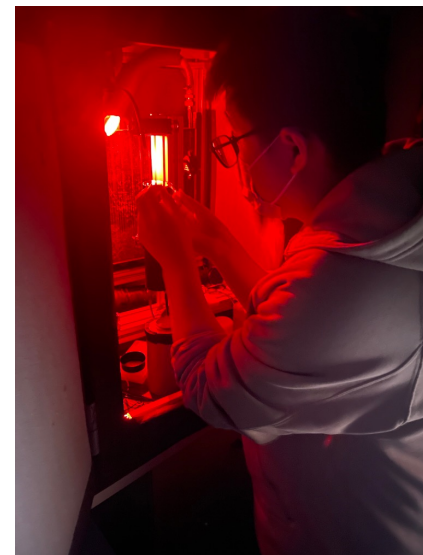
LHCb Upgrade Ib+II at China: GAGG crystal

➤ R&D of fast Cerium-doped Gadolinium Aluminum Gallium Garnet (GAGG) crystal (< 25 ns) with SIPAT in Chongqing

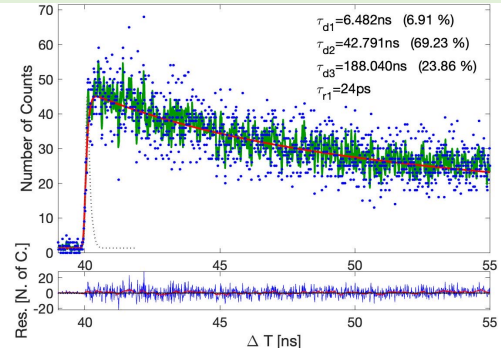
GAGG from SIPAT



Measuring light yield



Decay time measured at CERN



Decay time for different batches

Table 2: Scintillation rise time (τ_r), three decay times (τ_{d1} , τ_{d2} , τ_{d3}), and relative intensities of the corresponding components R_1 , R_2 , R_3 . The uncertainty is 25% and 5% for the rise and decay times, respectively. The first three

Batch	Location	τ_r [ns]	τ_{d1} [ns]	τ_{d2} [ns]	τ_{d3} [ns]	R_1 [%]	R_2 [%]	R_3 [%]
Batch1	Top2 #4424	62	9.2	6.2	54	68.7	267	25.1
Batch1	Top7 #4425	83	7.8	5.8	54	69.1	242	25.1
Batch1	Middle7 #4426	47	6.2	5.0	46	64.5	149	30.5
Batch1	Middle8 #4427	16	7.3	6.5	49	68.8	180	24.7
Batch1	Tail3 #4428	24	6.5	6.9	43	69.2	188	23.9
Batch1	Tail8 #4429	87	7.7	8.7	46	70.3	210	21.0
Batch2-ingot1	Top5 #4474	23	7.0	5.3	48	66.6	162	28.1
Batch2-ingot1	Top7 #4475	27	7.1	5.3	46	62.9	134	31.8
Batch2-ingot1	Middle1 #4476	28	6.4	6.7	47	70.5	172	22.8
Batch2-ingot1	Middle3 #4477	21	4.9	4.6	43	65.4	147	30.0
Batch2-ingot1	Tail6 #4478	26	5.4	6.7	42	70.5	206	22.9
Batch2-ingot1	Tail7 #4479	27	4.8	6.8	40	69.1	134	24.1
Batch2-ingot2	Top4 #4492	17	3.8	6.7	30	59.5	101	33.8
Batch2-ingot2	Top7 #4493	7	4.5	8.3	34	67.8	139	23.9
Batch2-ingot2	Middle2 #4494	21	5.0	8.6	36	69.1	134	22.4
Batch2-ingot2	Middle7 #4495	10	5.3	8.1	36	65.2	128	26.7
Batch2-ingot2	Tail5 #4496	11	3.6	8.8	29	66.0	124	25.3
Batch2-ingot2	Tail6 #4497	10	4.1	10.4	30	67.6	138	22.0

Decreasing

Decay times from 50 ns down to 25 ns, expect to finalise soon

LHCb Upgrade Ib+II at China: absorber

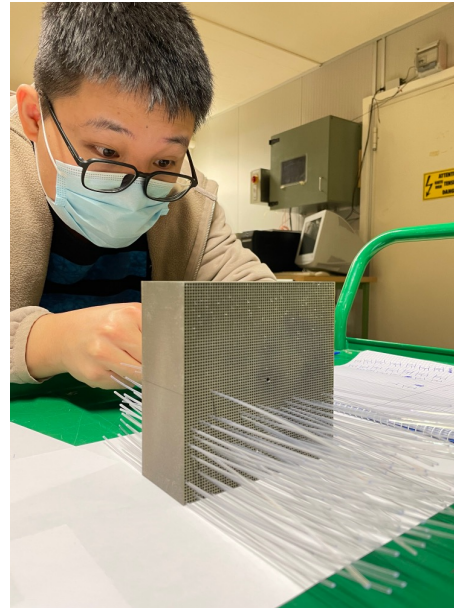
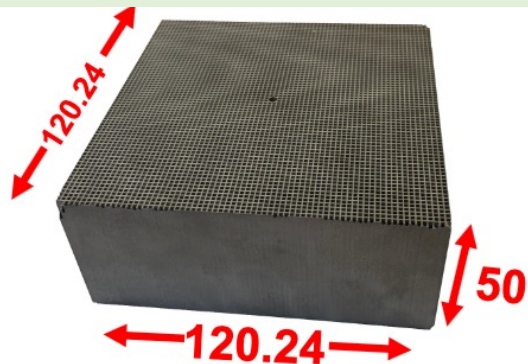
➤ 3D-print tungsten (W) absorber with LaserAdd in Zhuhai

Module size: $121 \times 121 \times 5 \text{ mm}^3$
5180 square holes of $1.2 \times 1.2 \text{ mm}^2$

Small modules printed by LaserAdd



Full-size module printed by LaserAdd

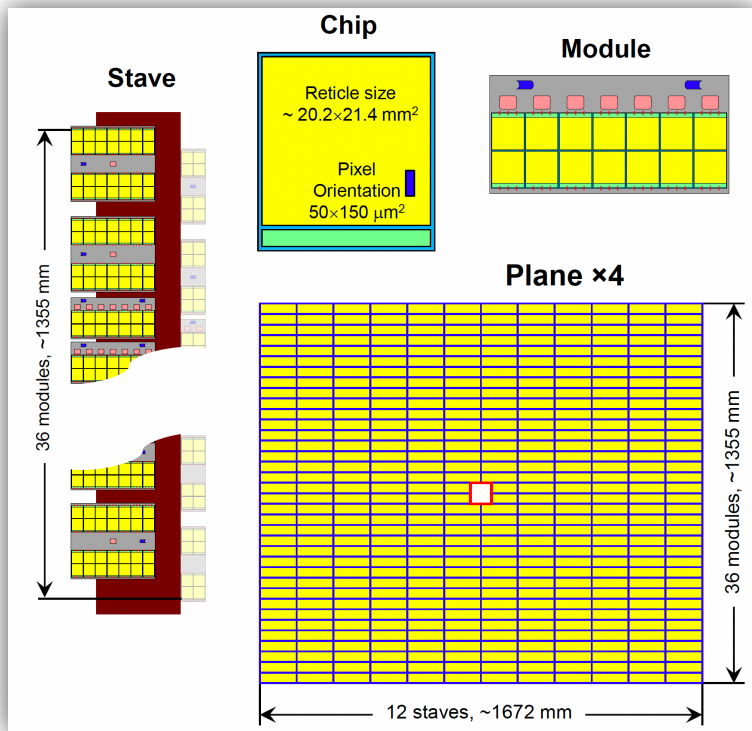


Roughness measurement at PKU

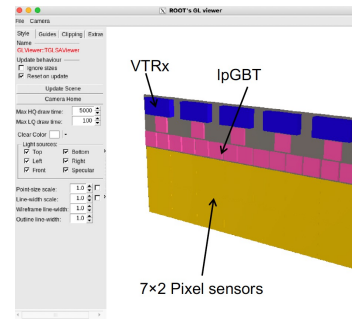
Similar quality as EOS produced in Germany

LHCb Upgrade 1b+II at China: UT

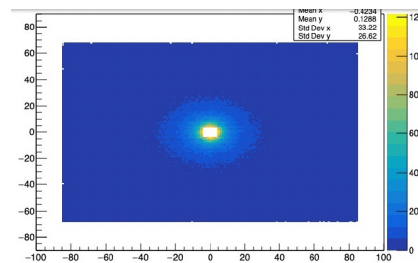
- Leading the R&D for CMOS-based UT upgrade
- Proposal of system design accepted in Framework TDR
- Jianchun Wang (IHEP) appointed as UT deputy project leader for UII



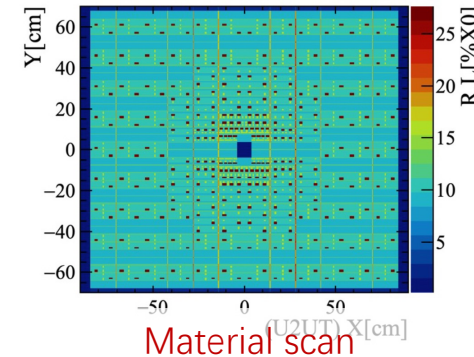
Design of CMOS-based UT upgrade



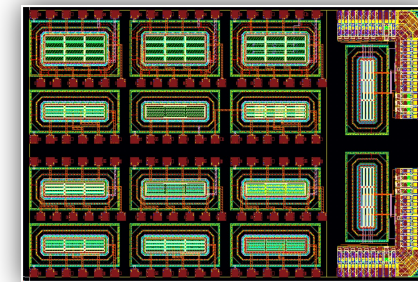
Detector modelling



Simulation of hits in
Run 5/6 condition



Material scan



HVCMOS design for MPW
using 55nm process

Prospects for Upgrade I and Upgrade II

CERN-LHCC-2021-012

- Collect 50 fb^{-1} by end of Run 4 and 300 fb^{-1} by end of Run 6
 - 9 fb^{-1} Collected in Run 1&2
- Aim at keeping same performance (or better) with Upgrades
- Several flagship measurements still statistically dominated and with uncertainty on predictions negligible compared to the experimental knowledge → great potential!

Observable	Run 1-2	Run 3-4		Run 5-6
	Current LHCb (up to 9 fb^{-1})	Upgrade I (23 fb^{-1})	Upgrade I (50 fb^{-1})	Upgrade II (300 fb^{-1})
CKM tests				
$\gamma (B \rightarrow DK, \text{etc.})$	4° [9, 10]	1.5°	1°	0.35°
$\phi_s (B_s^0 \rightarrow J/\psi \phi)$	32 mrad [8]	14 mrad	10 mrad	4 mrad
$ V_{ub} / V_{cb} (A_b^0 \rightarrow p\mu^- \bar{\nu}_\mu, \text{etc.})$	6% [29, 30]	3%	2%	1%
$a_{\text{sl}}^d (B^0 \rightarrow D^- \mu^+ \nu_\mu)$	36×10^{-4} [34]	8×10^{-4}	5×10^{-4}	2×10^{-4}
$a_{\text{sl}}^s (B_s^0 \rightarrow D_s^- \mu^+ \nu_\mu)$	33×10^{-4} [35]	10×10^{-4}	7×10^{-4}	3×10^{-4}
Charm				
$\Delta A_{CP} (D^0 \rightarrow K^+ K^-, \pi^+ \pi^-)$	29×10^{-5} [5]	13×10^{-5}	8×10^{-5}	3.3×10^{-5}
$A_\Gamma (D^0 \rightarrow K^+ K^-, \pi^+ \pi^-)$	11×10^{-5} [38]	5×10^{-5}	3.2×10^{-5}	1.2×10^{-5}
$\Delta x (D^0 \rightarrow K_S^0 \pi^+ \pi^-)$	18×10^{-5} [37]	6.3×10^{-5}	4.1×10^{-5}	1.6×10^{-5}
Rare Decays				
$\mathcal{B}(B^0 \rightarrow \mu^+ \mu^-)/\mathcal{B}(B_s^0 \rightarrow \mu^+ \mu^-)$	69% [40, 41]	41%	27%	11%
$S_{\mu\mu} (B_s^0 \rightarrow \mu^+ \mu^-)$	—	—	—	0.2
$A_T^{(2)} (B^0 \rightarrow K^{*0} e^+ e^-)$	0.10 [52]	0.060	0.043	0.016
$A_T^{\text{Im}} (B^0 \rightarrow K^{*0} e^+ e^-)$	0.10 [52]	0.060	0.043	0.016
$\mathcal{A}_{\phi\gamma}^{\Delta\Gamma} (B_s^0 \rightarrow \phi\gamma)$	$+0.41$ -0.44 [51]	0.124	0.083	0.033
$S_{\phi\gamma} (B_s^0 \rightarrow \phi\gamma)$	0.32 [51]	0.093	0.062	0.025
$\alpha_\gamma (A_b^0 \rightarrow A\gamma)$	$+0.17$ -0.29 [53]	0.148	0.097	0.038
Lepton Universality Tests				
$R_K (B^+ \rightarrow K^+ \ell^+ \ell^-)$	0.044 [12]	0.025	0.017	0.007
$R_{K^*} (B^0 \rightarrow K^{*0} \ell^+ \ell^-)$	0.12 [61]	0.034	0.022	0.009
$R(D^*) (B^0 \rightarrow D^{*-} \ell^+ \nu_\ell)$	0.026 [62, 64]	0.007	0.005	0.002

Summary

- The past: A very successful operation leading to excellent results
 - Physics program expanded well beyond original expectation: heavy-ion, fix-target, EW, ...
- The present: LHCb Upgrade I
 - A first major upgrade during LS2 → brand new detector
 - Removal of L0 hardware trigger
 - High-level software trigger running at 30 MHz on GPUs
 - New trackers (VELO, [UT](#), [SciFi](#))
 - Upgraded RICH 1&2 with new photodetectors and readout electronics
 - ECAL, HCAL and MUON upgraded with new readout electronics
 - New fixed-target system (SMOG2) to inject various gases
 - New dedicated luminometer (PLUME)
- The future: LHCb Upgrade Ib&II
 - Replace some parts close to beam for Upgrade Ib during LS3
 - A second major upgrade during LS4: timing, granularity, radiation resistance, ...
 - Many R&D ongoing in China: [ECAL](#), [UT](#)
 - GAGG crystal, 3D-print tungsten absorber, CMOS, ...

Thanks!